

Principle and Interface Techniques of Microcontroller

--8051 Microcontroller and Embedded Systems
Using Assembly and C

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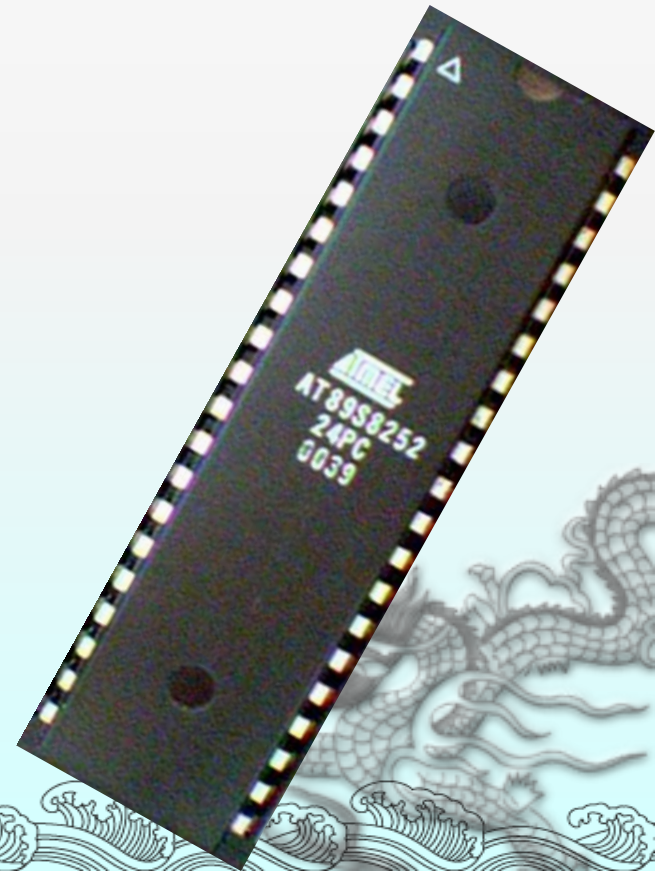
Chapter 13

Real-world Interfacing LCD, ADC, and DAC



Outline

- ◆ § 13-1 LCD and Keyboard Interfacing
- ◆ § 13-2 Interfacing to ADC
- ◆ § 13-3 Interfacing to DAC



§ 13-1 LCD and Keyboard Interfacing

LCD Operation

- ◆ LCD is finding widespread use replacing LEDs
 - The declining prices of LCD
 - The ability to display numbers, characters, and graphics
 - Incorporation of a refreshing controller into the LCD, thereby relieving the CPU of the task of refreshing the LCD
 - Ease of programming for characters and graphics



Pin Descriptions for LCD

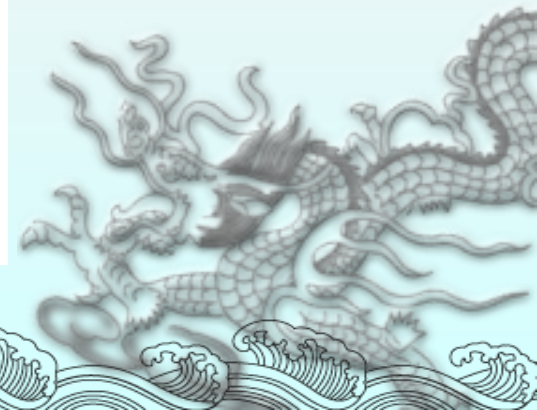
Pin	Symbol	I/O	Descriptions
1	VSS	--	Ground
2	VCC	--	+5V power supply
3	VEE	--	Power supply to control contrast
4	RS	I	RS=0 to select command register, RS=1 to select data register
5	R/W	I	R/W=0 for write, R/W=1 for read
6	E	I/O	Enable
7	DB0	I/O	The 8-bit data bus
8	DB1	I/O	The 8-bit data bus
9	DB2	I/O	The 8-bit data bus
10	DB3	I/O	The 8-bit data bus
11	DB4	I/O	The 8-bit data bus
12	DB5	I/O	The 8-bit data bus
13	DB6	I/O	The 8-bit data bus
14	DB7	I/O	The 8-bit data bus

- Send displayed information or instruction command codes to the LCD
- Read the contents of the LCD's internal registers

used by the LCD to latch information presented to its data bus

LCD Command Codes

Code (Hex)	Command to LCD Instruction Register
1	Clear display screen
2	Return home
4	Decrement cursor (shift cursor to left)
6	Increment cursor (shift cursor to right)
5	Shift display right
7	Shift display left
8	Display off, cursor off
A	Display off, cursor on
C	Display on, cursor off
E	Display on, cursor blinking
F	Display on, cursor blinking
10	Shift cursor position to left
14	Shift cursor position to right
18	Shift the entire display to the left
1C	Shift the entire display to the right
80	Force cursor to beginning to 1st line
C0	Force cursor to beginning to 2nd line
38	2 lines and 5x7 matrix



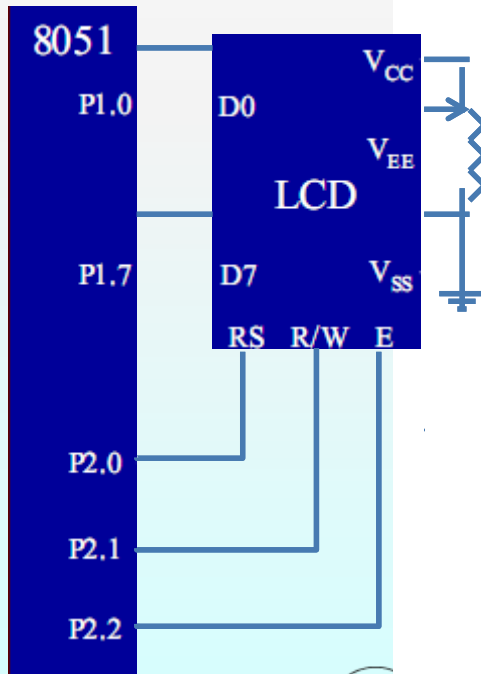
Sending Codes and Data to LCDs w/ Time Delay

To send any of the commands to the LCD, make pin RS=0. For data, make RS=1. Then send a high-to-low pulse to the E pin to enable the internal latch of the LCD. This is shown in the code below.

```
;calls a time delay before sending next data/command  
;P1.0-P1.7 are connected to LCD data pins D0-D7  
;P2.0 is connected to RS pin of LCD  
;P2.1 is connected to R/W pin of LCD  
;P2.2 is connected to E pin of LCD
```

```
ORG
```

```
MOV    A,#38H    ;INIT. LCD 2 LINES, 5X7 MATRIX  
ACALL  COMNWRT   ;call command subroutine  
ACALL  DELAY     ;give LCD some time  
MOV    A,#0EH    ;display on, cursor on  
ACALL  COMNWRT   ;call command subroutine  
ACALL  DELAY     ;give LCD some time  
MOV    A,#01     ;clear LCD  
ACALL  COMNWRT   ;call command subroutine  
ACALL  DELAY     ;give LCD some time  
MOV    A,#06H    ;shift cursor right  
ACALL  COMNWRT   ;call command subroutine  
ACALL  DELAY     ;give LCD some time  
MOV    A,#84H    ;cursor at line 1, pos. 4  
ACALL  COMNWRT   ;call command subroutine  
ACALL  DELAY     ;give LCD some time
```



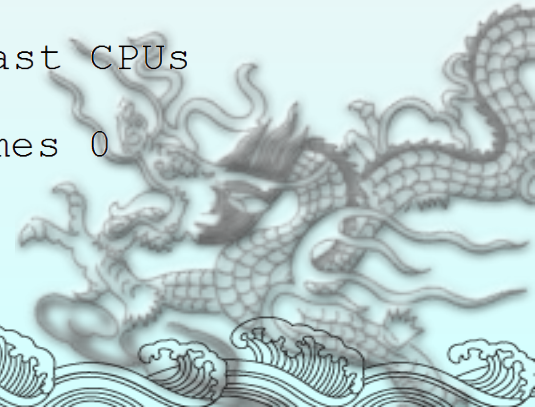
```

        MOV    A,#'N'    ;display letter N
        ACALL  DATAWRT  ;call display subroutine
        ACALL  DELAY     ;give LCD some time
        MOV    A,#'O'    ;display letter O
        ACALL  DATAWRT  ;call display subroutine
AGAIN:   SJMP   AGAIN     ;stay here
COMNWRT:                               ;send command to LCD
        MOV    P1,A       ;copy reg A to port 1
        CLR    P2.0       ;RS=0 for command
        CLR    P2.1       ;R/W=0 for write
        SETB   P2.2       ;E=1 for high pulse
        ACALL  DELAY     ;give LCD some time
        CLR    P2.2       ;E=0 for H-to-L pulse
        RET

DATAWRT:                               ;write data to LCD
        MOV    P1,A       ;copy reg A to port 1
        SETB   P2.0       ;RS=1 for data
        CLR    P2.1       ;R/W=0 for write
        SETB   P2.2       ;E=1 for high pulse
        ACALL  DELAY     ;give LCD some time
        CLR    P2.2       ;E=0 for H-to-L pulse
        RET

DELAY:   MOV    R3,#50    ;50 or higher for fast CPUs
HERE2:   MOV    R4,#255   ;R4 = 255
HERE:    DJNZ   R4,HERE   ;stay until R4 becomes 0
        DJNZ   R3,HERE2
        RET
        END

```




```
;Check busy flag before sending data, command to LCD
;pl=data pin
;P2.0 connected to RS pin
;P2.1 connected to R/W pin
;P2.2 connected to E pin
    ORG
    MOV     A, #38H           ;init. LCD 2 lines ,5x7 matrix
    ACALL  COMMAND           ;issue command
    MOV     A, #0EH           ;LCD on, cursor on
    ACALL  COMMAND           ;issue command
    MOV     A, #01H           ;clear LCD command
    ACALL  COMMAND           ;issue command
    MOV     A, #06H           ;shift cursor right
    ACALL  COMMAND           ;issue command
    MOV     A, #86H           ;cursor: line 1, pos. 6
    ACALL  COMMAND           ;command subroutine
    MOV     A, #'N'           ;display letter N
    ACALL  DATA_DISPLAY
    MOV     A, #'O'           ;display letter O
    ACALL  DATA_DISPLAY
    HERE: SJMP  HERE           ;STAY HERE
```

COMMAND:

```
ACALL READY    ;is LCD ready?
MOV  P1,A      ;issue command code
CLR  P2.0      ;RS=0 for command
CLR  P2.1      ;R/W=0 to write to LCD
SETB P2.2      ;E=1 for H-to-L pulse
CLR  P2.2      ;E=0,latch in
RET
```

DATA_DISPLAY:

```
ACALL READY    ;is LCD ready?
MOV  P1,A      ;issue data
SETB P2.0      ;RS=1 for data
CLR  P2.1      ;R/W =0 to write to LCD
SETB P2.2      ;E=1 for H-to-L pulse
CLR  P2.2      ;E=0,latch in
RET
```

READY:

```
SETB P1.7      ;make P1.7 input port
CLR  P2.0      ;RS=0 access command reg
SETB P2.1      ;R/W=1 read command reg
```

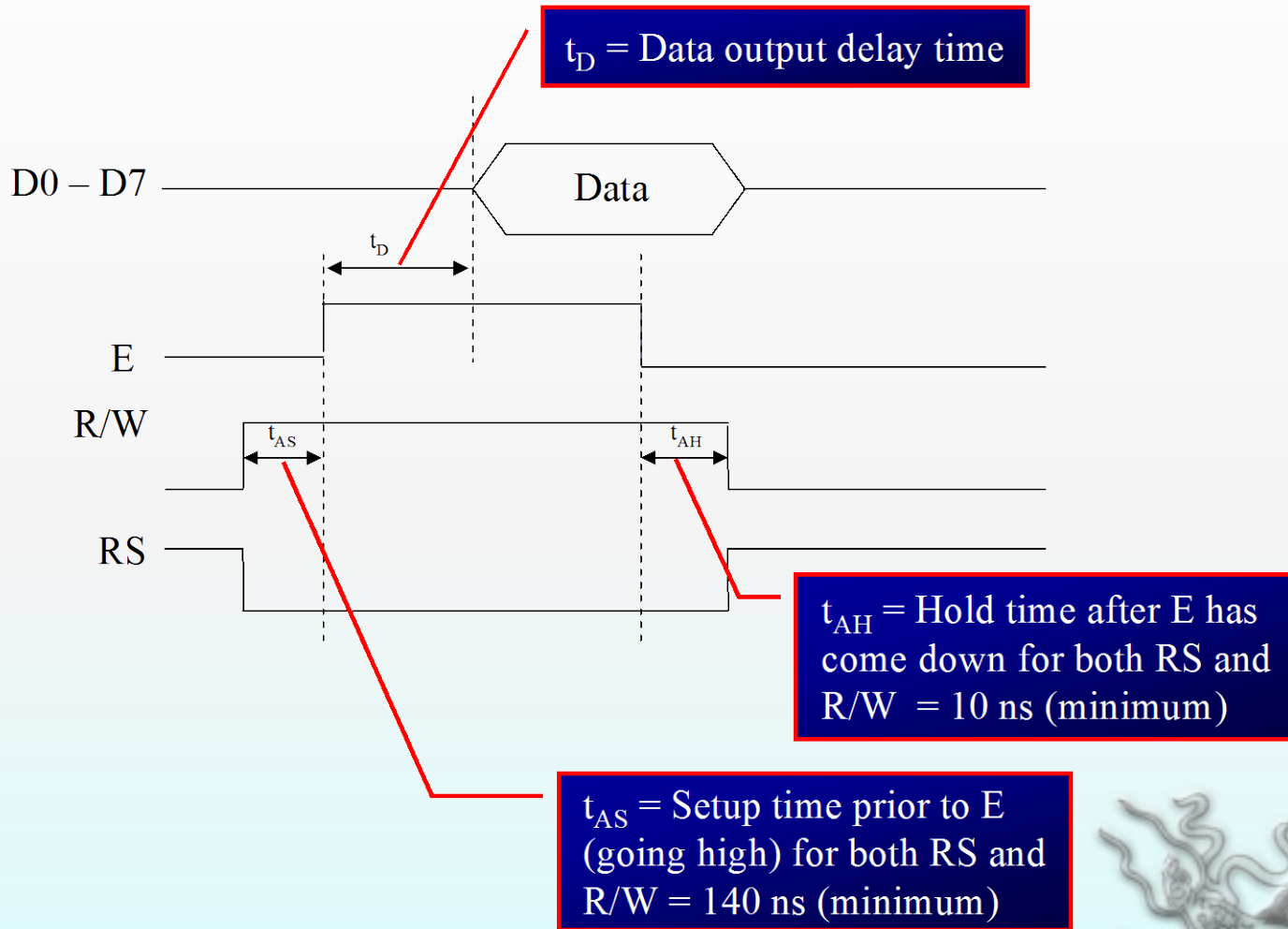
;read command reg and check busy flag

```
BACK: SETB P2.2 ;E=1 for H-to-L pulse
      CLR  P2.2 ;E=0 H-to-L pulse
      JB   P1.7, BACK ;stay until busy flag=0
      RET
      END
```

To read the command register, we make R/W=1, RS=0, and a H-to-L pulse for the E pin.

If bit 7 (busy flag) is high, the LCD is busy and no information should be issued to it.

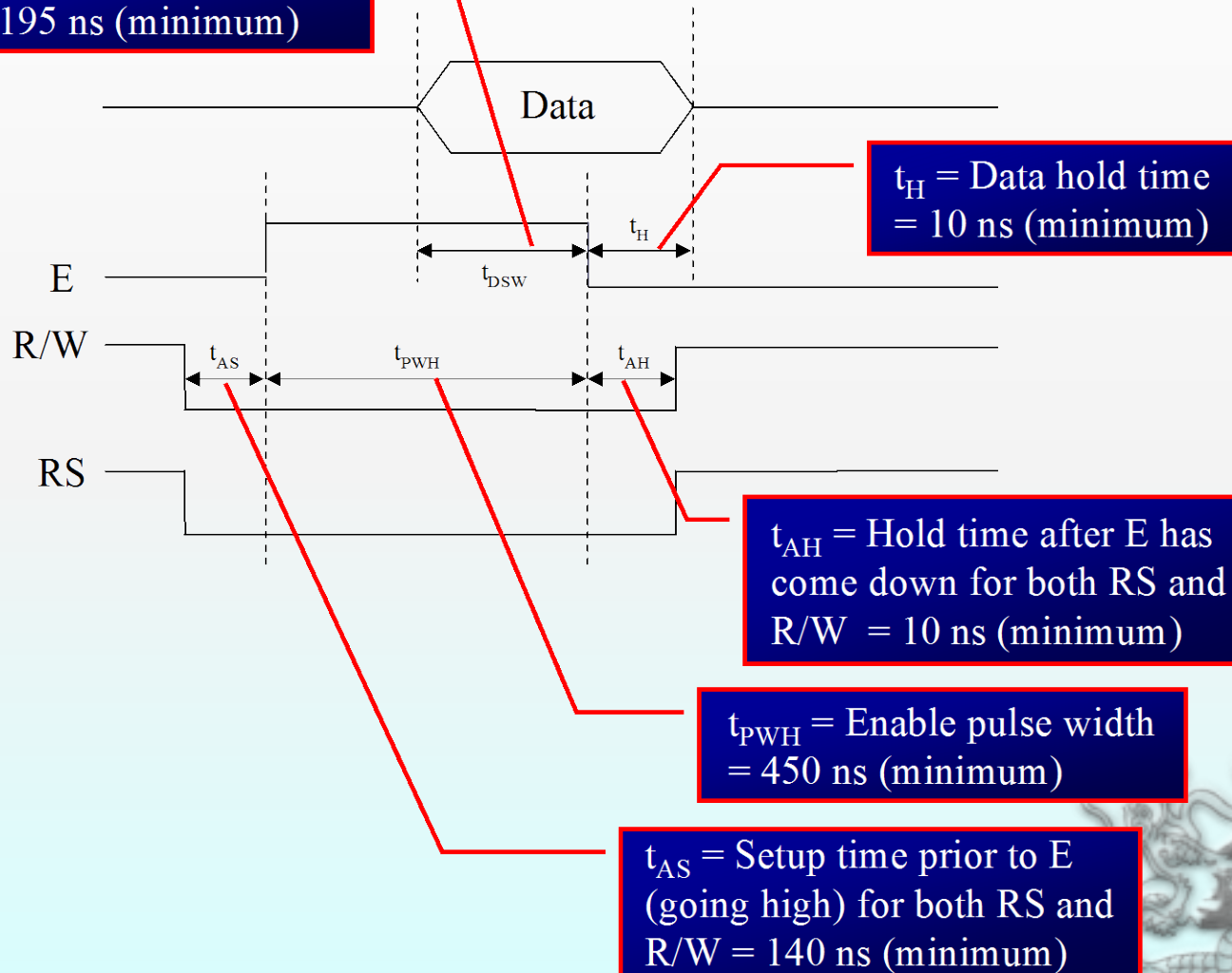
LCD Timing for Read



Note : Read requires an L-to-H pulse for the E pin

LCD Timing for Write

t_{DSW} = Data set up time
= 195 ns (minimum)



t_H = Data hold time
= 10 ns (minimum)

t_{AH} = Hold time after E has
come down for both RS and
R/W = 10 ns (minimum)

t_{PWH} = Enable pulse width
= 450 ns (minimum)

t_{AS} = Setup time prior to E
(going high) for both RS and
R/W = 140 ns (minimum)

- One can put data at any location in the LCD and the following shows address locations and how they are accessed

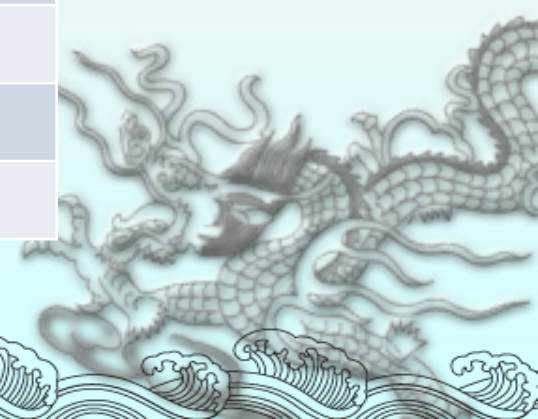
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	A	A	A	A	A	A	A

- AAAAAAA=000_0000 to 010_0111 for
- AAAAAAA=100_0000 to 110_0111 for

The upper address range can go as high as 0100111 for the 40-character-wide LCD, which corresponds to locations 0 to 39

LCD Addressing for the LCDs of 40×2 size

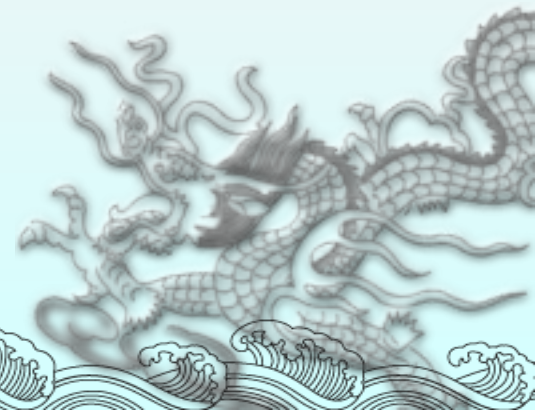
	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Line1 (min)	1	0	0	0	0	0	0	0
Line1 (max)	1	0	1	0	0	1	1	1
Line2 (min)	1	1	0	0	0	0	0	0
Line2 (max)	1	1	1	0	0	1	1	1



Write an 8051 C program to send letters 'M', 'D', and 'E' to the LCD using the busy flag method.

Solution:

```
#include <reg51.h>
sfr ldata = 0x90; //P1=LCD data pins
sbit rs = P2^0;
sbit rw = P2^1;
sbit en = P2^2;
sbit busy = P1^7;
void main(){
    lcdcmd(0x38);
    lcdcmd(0x0E);
    lcdcmd(0x01);
    lcdcmd(0x06);
    lcdcmd(0x86); //line 1, position 6
    lcdcmd('M');
    lcdcmd('D');
    lcdcmd('E');
}
.....
```



```

void lcdcmd(unsigned char value){
    lcdready();    //check the LCD busy flag
    ldata = value; //put the value on the pins
    rs = 0;
    rw = 0;
    en = 1;        //strobe the enable pin
    MSDelay(1);
    en = 0;
    return;
}

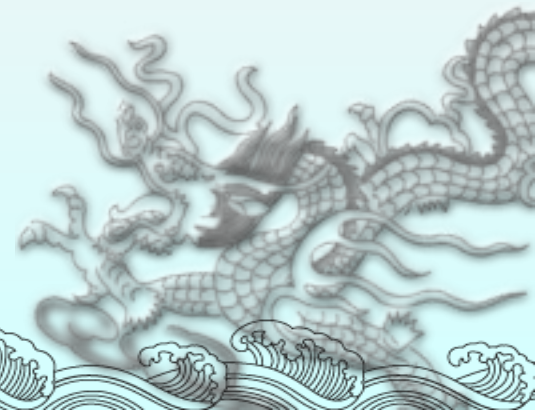
void lcddata(unsigned char value){
    lcdready();    //check the LCD busy flag
    ldata = value; //put the value on the pins
    rs = 1;
    rw = 0;
    en = 1;        //strobe the enable pin
    MSDelay(1);
    en = 0;
    return;
}
.....

```

```

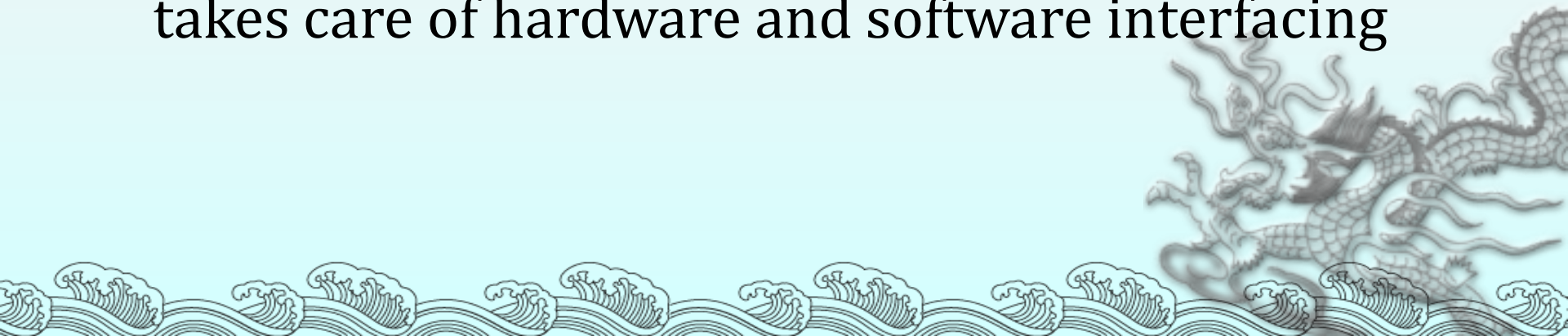
.....
void lcdready(){
    busy = 1; //make the busy pin at input
    rs = 0;
    rw = 1;
    while(busy==1){
        //wait here for busy flag
        en = 0;        //strobe the enable pin
        MSDelay(1);
    }
    en = 1;
}

```



Keyboard Interfacing

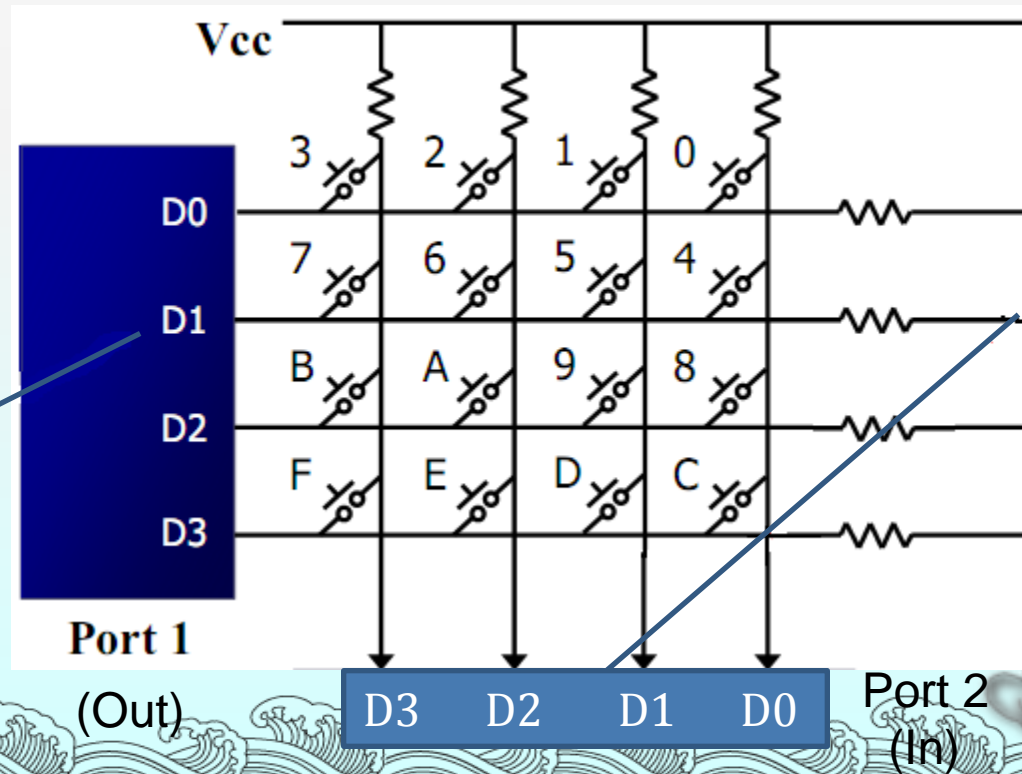
- ◆ Keyboards are organized in a matrix of rows and columns
 - The CPU accesses both rows and columns through ports
 - ✓ Therefore, with two 8-bit ports, an 8 x 8 matrix of keys can be connected to a microprocessor
 - When a key is pressed, a row and a column make a contact
 - ✓ Otherwise, there is no connection between rows and columns
- ◆ In IBM PC keyboards, a single microcontroller takes care of hardware and software interfacing



Scanning and Identifying the Key

- ◆ A 4x4 matrix connected to two ports
 - The rows are connected to an output port and the columns are connected to an input port

Matrix Keyboard Connection to ports



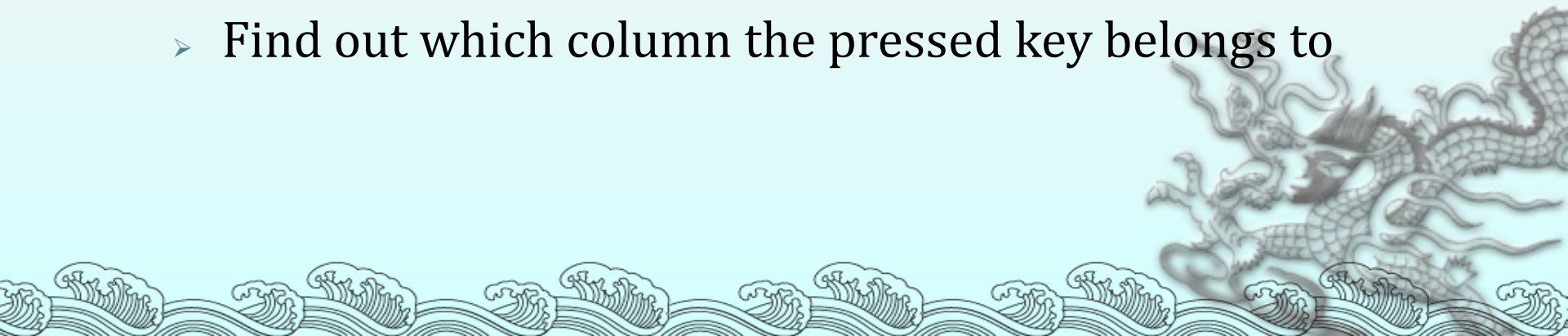
If all the rows are grounded and a key is pressed, one of the columns will have 0 since the key pressed provides the path to ground

If no key has been pressed, reading the input port will yield 1s for all columns since they are all connected to high (Vcc)

Grounding Rows and Reading Columns

- ❖ It is the function of the microcontroller to scan the keyboard continuously to detect and identify the key pressed
- ❖ To detect a pressed key, the microcontroller grounds all rows by providing 0 to the output latch, then it reads the columns
 - If the data read from columns is $D3 - D0 = 1111$, no key has been pressed and the process continues till key press is detected
 - If one of the column bits has a zero, this means that a key press has occurred
 - ✓ For example, if $D3 - D0 = 1101$, this means that a key in the D1 column has been pressed. After detecting a key press, microcontroller will go through the process of identifying the key

- ◆ Starting with the top row, the microcontroller grounds it by providing a low to row D0 only
 - It reads the columns, if the data read is all 1s, no key in that row is activated and the process is moved to the next row
- ◆ It grounds the next row, reads the columns, and checks for any zero
 - This process continues until the row is identified
- ◆ After identification of the row in which the key has been pressed
 - Find out which column the pressed key belongs to



From Figure 12-6, identify the row and column of the pressed key for each of the following.

(a) $D3 - D0 = 1110$ for the row, $D3 - D0 = 1011$ for the column

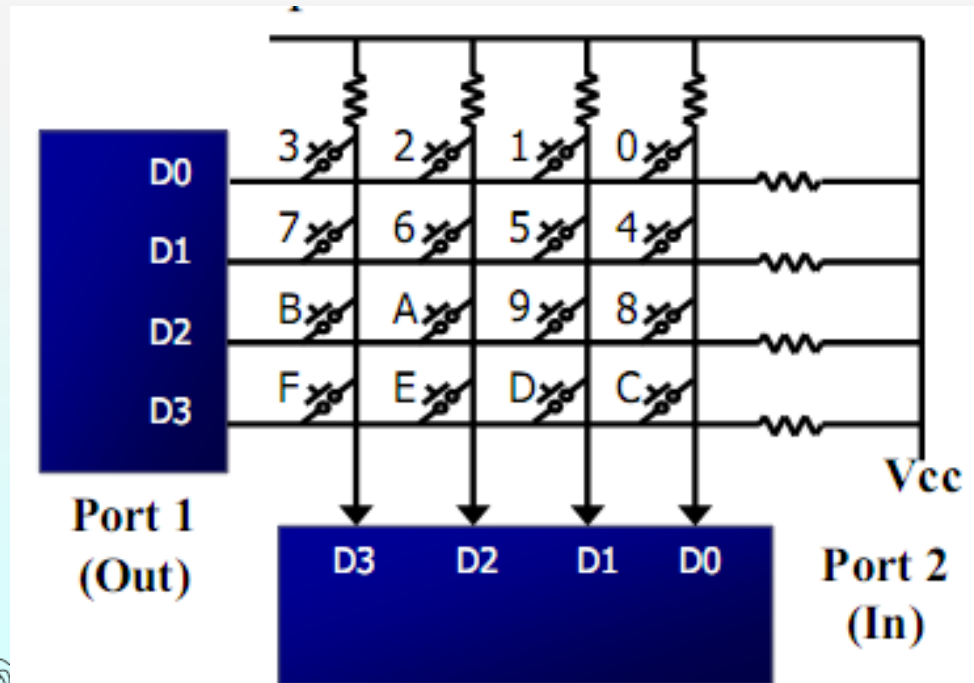
(b) $D3 - D0 = 1101$ for the row, $D3 - D0 = 0111$ for the column

Solution :

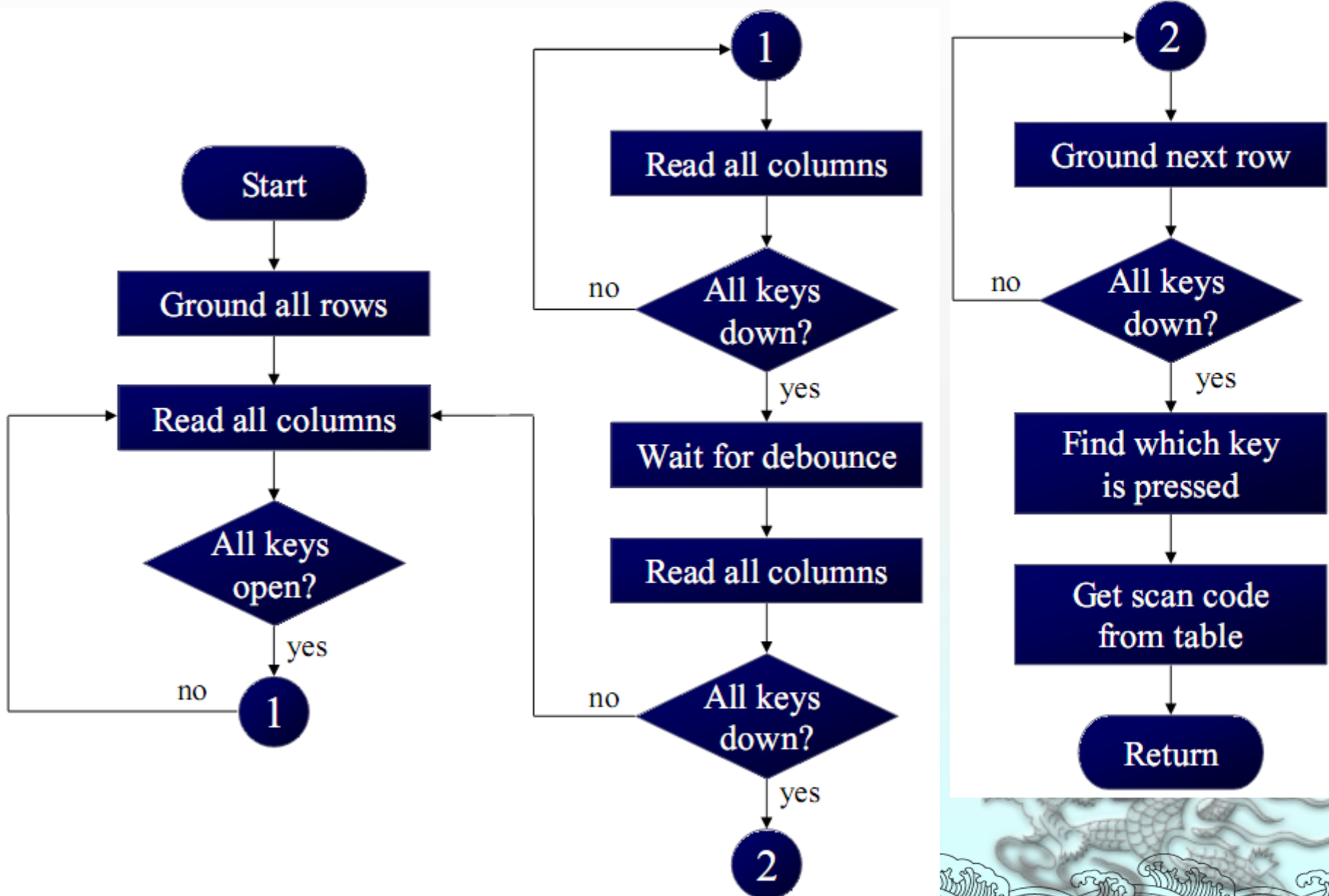
From Figure 13-5 the row and column can be used to identify the key.

(a) The row belongs to D0 and the column belongs to D2; therefore, key number 2 was pressed.

(b) The row belongs to D1 and the column belongs to D3; therefore, key number 7 was pressed.



Flowchart for Program



;keyboard subroutine. This program sends the ASCII
;code for pressed key to P0.1
;P1.0-P1.3 connected to rows, P2.0-P2.3 to column

```
      MOV    P2,#0FFH    ;make P2 an input port
K1:    MOV    P1,#0       ;ground all rows at once
      MOV    A,P2        ;read all col
                        ;(ensure keys open)
      ANL    A,00001111B ;masked unused bits
      CJNE   A,#00001111B,K1 ;till all keys release
K2:    ACALL  DELAY      ;call 20 msec delay
      MOV    A,P2        ;see if any key is pressed
      ANL    A,00001111B ;mask unused bits
      CJNE   A,#00001111B,OVER;key pressed, find row
      SJMP   K2          ;check till key pressed
OVER:  ACALL  DELAY      ;wait 20 msec debounce time
      MOV    A,P2        ;check key closure
      ANL    A,00001111B ;mask unused bits
      CJNE   A,#00001111B,OVER1;key pressed, find row
      SJMP   K2          ;if none, keep polling
```

.....

```
OVER1:  MOV P1, #11111110B    ;ground row 0
        MOV A,P2              ;read all columns
        ANL A,#00001111B     ;mask unused bits
        CJNE A,#00001111B,ROW_0 ;key row 0, find col.
        MOV P1,#11111101B    ;ground row 1
        MOV A,P2              ;read all columns
        ANL A,#00001111B     ;mask unused bits
        CJNE A,#00001111B,ROW_1 ;key row 1, find col.
        MOV P1,#11111011B    ;ground row 2
        MOV A,P2              ;read all columns
        ANL A,#00001111B     ;mask unused bits
        CJNE A,#00001111B,ROW_2 ;key row 2, find col.
        MOV P1,#11110111B    ;ground row 3
        MOV A,P2              ;read all columns
        ANL A,#00001111B     ;mask unused bits
        CJNE A,#00001111B,ROW_3 ;key row 3, find col.
        LJMP K2                ;if none, false input,
                                ;repeat
```

.....


```

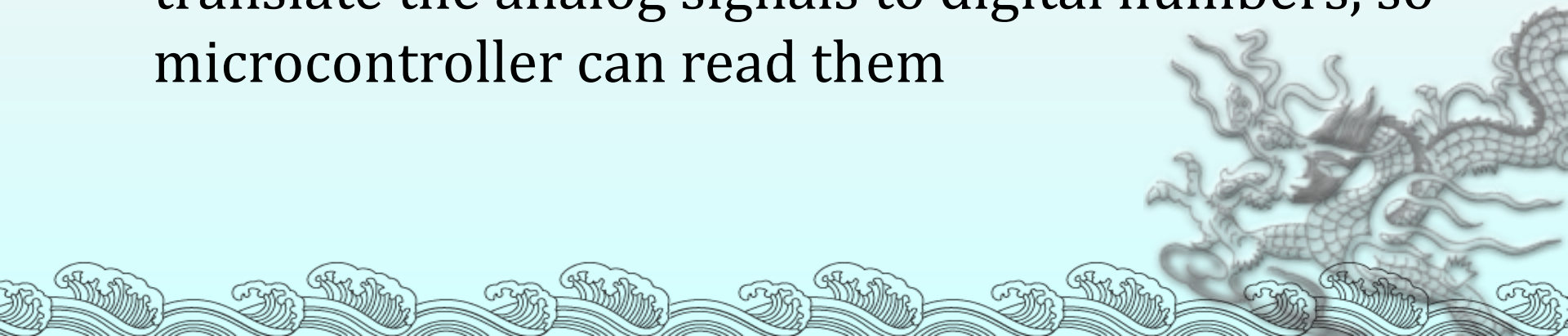
.....
ROW_0:  MOV  DPTR,#KCODE0      ;set DPTR=start of row 0
        SJMP FIND              ;find col. Key belongs to
ROW_1:  MOV  DPTR,#KCODE1      ;set DPTR=start of row
        SJMP FIND              ;find col. Key belongs to
ROW_2:  MOV  DPTR,#KCODE2      ;set DPTR=start of row 2
        SJMP FIND              ;find col. Key belongs to
ROW_3:  MOV  DPTR,#KCODE3      ;set DPTR=start of row 3
FIND:   RRC  A                  ;see if any CY bit low
        JNC  MATCH              ;if zero, get ASCII code
        INC  DPTR              ;point to next col. addr
        SJMP FIND              ;keep searching
MATCH:  CLR  A                  ;set A=0 (match is found)
        MOVC A,@A+DPTR         ;get ASCII from table
        MOV  P0,A              ;display pressed key
        LJMP K1
;ASCII LOOK-UP TABLE FOR EACH ROW
        ORG  300H
KCODE0: DB  '0','1','2','3' ;ROW 0
KCODE1: DB  '4','5','6','7' ;ROW 1
KCODE2: DB  '8','9','A','B' ;ROW 2
KCODE3: DB  'C','D','E','F' ;ROW 3
        END

```

§ 13-2 Interfacing to ADC and DAC

ADC Devices

- ◆ ADCs (analog-to-digital converters) are among the most widely used devices for data acquisition
 - A physical quantity, like temperature, pressure, humidity, and velocity, etc., is converted to electrical (voltage, current) signals using a device called a transducer, or sensor
- ◆ We need an analog-to-digital converter to translate the analog signals to digital numbers, so microcontroller can read them



ADC Principle

◆ 积分型

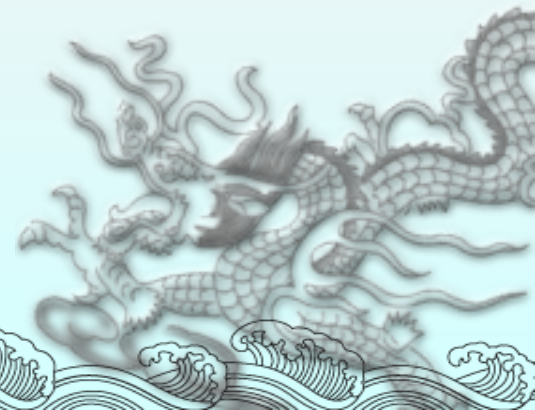
- ◆ 输入电压通过积分电路转换成时间(脉冲宽度信号)或频率(脉冲频率)，转换速率极低；

◆ 逐次比较型

- ◆ 由一个比较器和DA转换器通过逐次比较逻辑构成，速度较高、功耗低，低分辨率（<12位）时价格便宜；

◆ 并行比较型/串并行比较型

- ◆ 电路规模极大，转换速率极高；



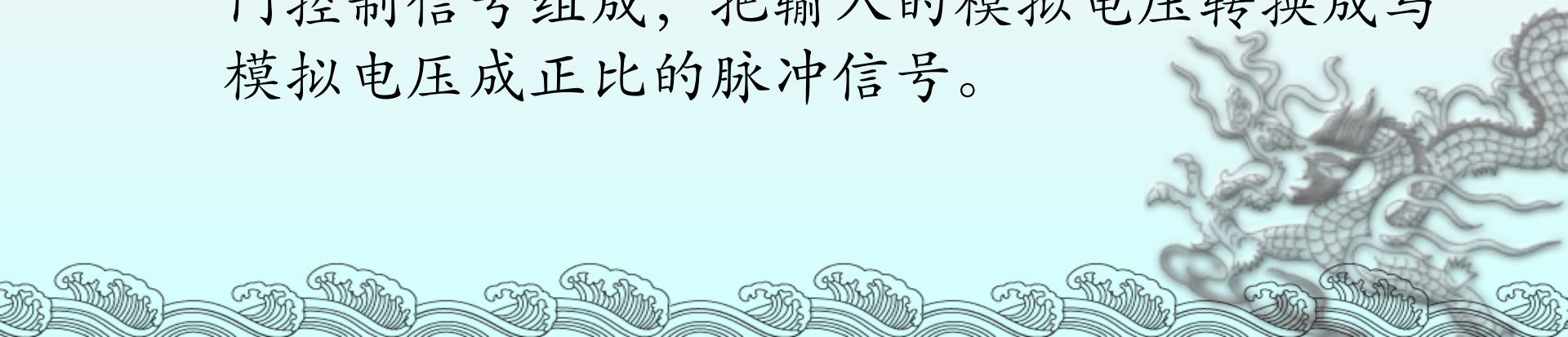
ADC Principle (2)

◆ Σ - Δ (Sigma/delta)调制型

- ◆ 信号采样，负反馈网络对量化噪声进行低频衰减，高频放大，用数字滤波器滤除带外噪声；

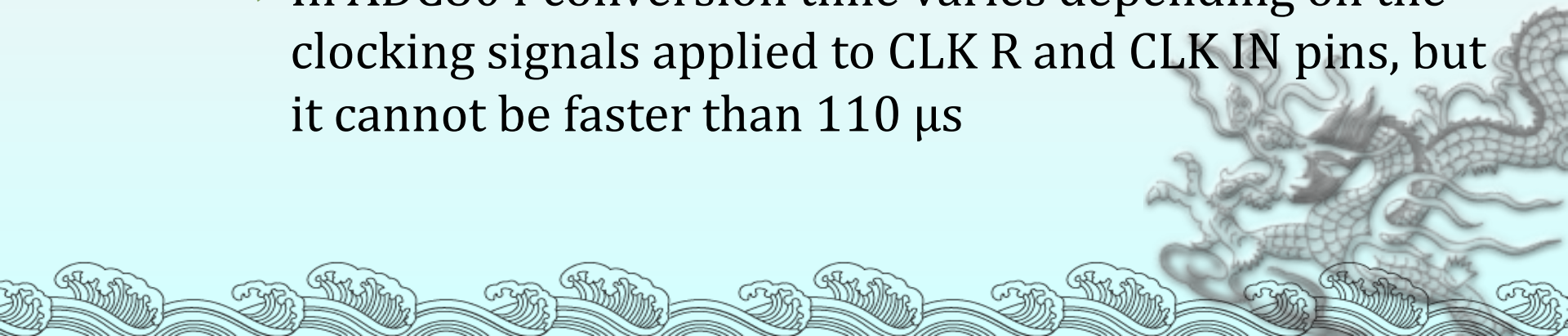
◆ 压频变换型

- ◆ 由计数器、控制门及一个具有恒定时间的时钟门控制信号组成，把输入的模拟电压转换成与模拟电压成正比的脉冲信号。



ADC0804 Chip

- ◆ ADC0804 IC is an analog-to-digital converter
 - It works with +5 volts and has a resolution of 8 bits
 - Conversion time is another major factor in judging an ADC
 - ✓ Conversion time is defined as the time it takes the ADC to convert the analog input to a digital (binary) number
 - ✓ In ADC804 conversion time varies depending on the clocking signals applied to CLK R and CLK IN pins, but it cannot be faster than $110\ \mu\text{s}$



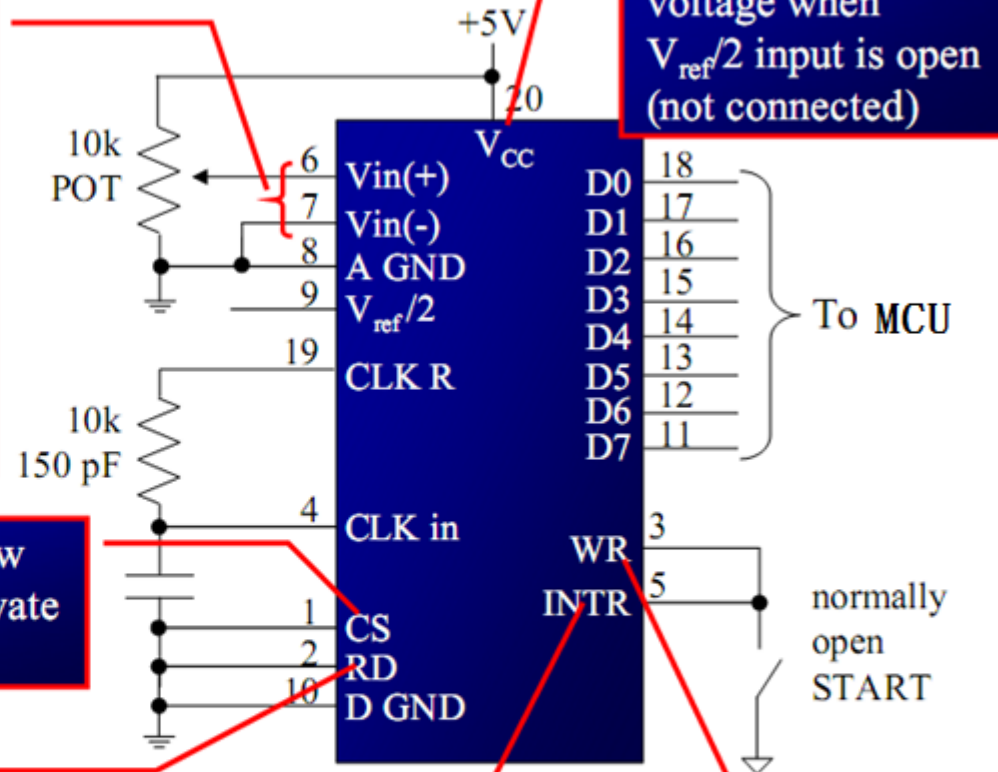
Differential analog inputs where $V_{in} = V_{in}(+) - V_{in}(-)$
 $V_{in}(-)$ is connected to ground and $V_{in}(+)$ is used as the analog input to be converted

CS is an active low input used to activate ADC804

“output enable”
a high-to-low RD pulse is used to get the 8-bit converted data out of ADC804

“end of conversion”
When the conversion is finished, it goes low to signal the CPU that the converted data is ready to be picked up

“start conversion”
When WR makes a low-to-high transition, ADC804 starts converting the analog input value of V_{in} to an 8-bit digital number



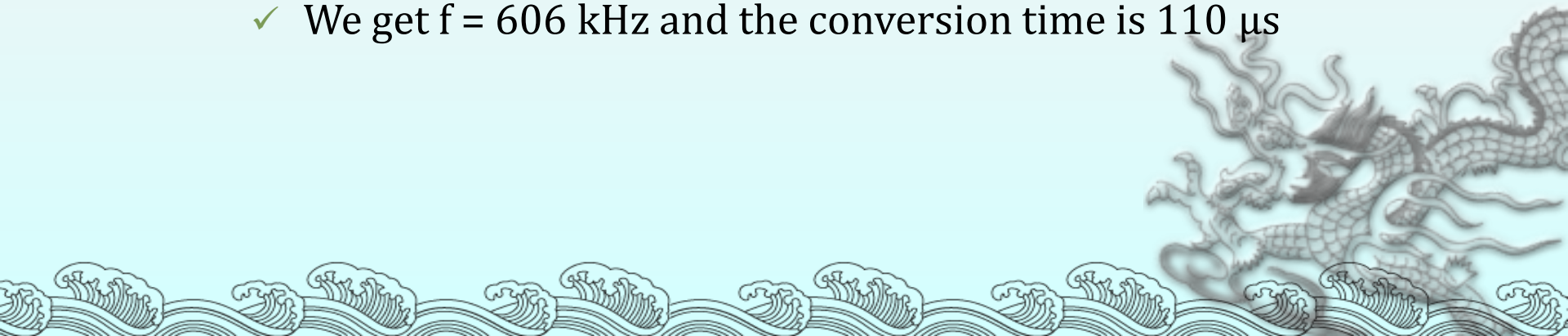
+5V power supply
or a reference
voltage when
 $V_{ref}/2$ input is open
(not connected)

◆ CLK IN and CLK R

- CLK IN is an input pin connected to an external clock source
- To use the internal clock generator (also called self-clocking), CLK IN and CLK R pins are connected to a capacitor and a resistor, and the clock frequency is determined by

$$f = \frac{1}{1.1RC}$$

- ✓ Typical values are $R = 10K$ ohms and $C = 150$ pF
- ✓ We get $f = 606$ kHz and the conversion time is $110 \mu s$



◆ $V_{\text{ref}}/2$

- It is used for the reference voltage
 - ✓ If this pin is open (not connected), the analog input voltage is in the range of 0 to 5 volts (the same as the V_{cc} pin)
 - ✓ If the analog input range needs to be 0 to 4 volts, $V_{\text{ref}}/2$ is connected to 2 volts

$V_{\text{ref}}/2$ Relation to V_{in} Range

$V_{\text{ref}}/2(\text{v})$	$V_{\text{in}}(\text{V})$	Step Size (mV)
Not connected*	0 to 5	$5/256=19.53$
2.0	0 to 4	$4/255=15.62$
1.5	0 to 3	$3/256=11.71$
1.28	0 to 2.56	$2.56/256=10$
1.0	0 to 2	$2/256=7.81$
0.5	0 to 1	$1/256=3.90$

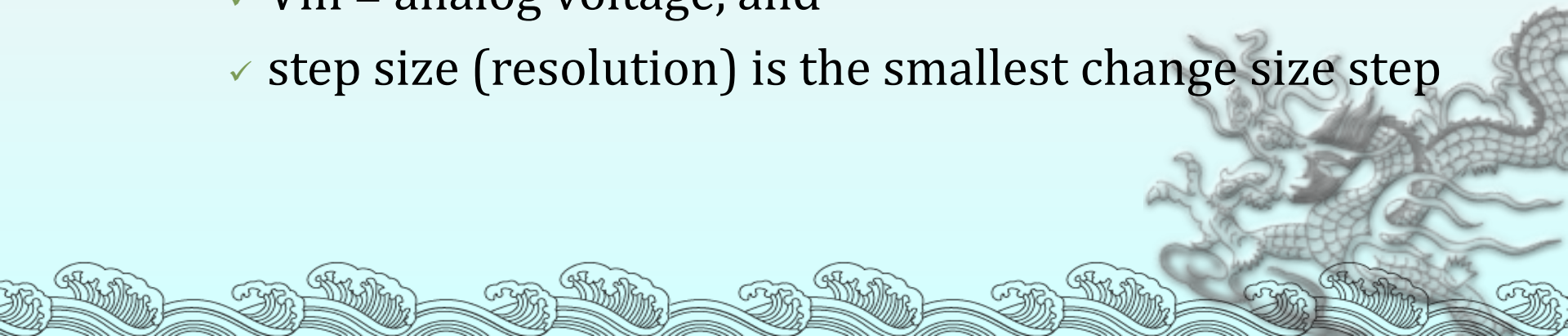
Step size is the smallest change can be discerned by an ADC

◆ D0-D7

- The digital data output pins
- These are tri-state buffered
 - ✓ The converted data is accessed only when CS = 0 and RD is forced low
- To calculate the output voltage, use the following formula

$$D_{\text{out}} = \frac{V_{\text{in}}}{\text{stepsize}}$$

- ✓ Dout = digital data output (in decimal),
- ✓ Vin = analog voltage, and
- ✓ step size (resolution) is the smallest change size step

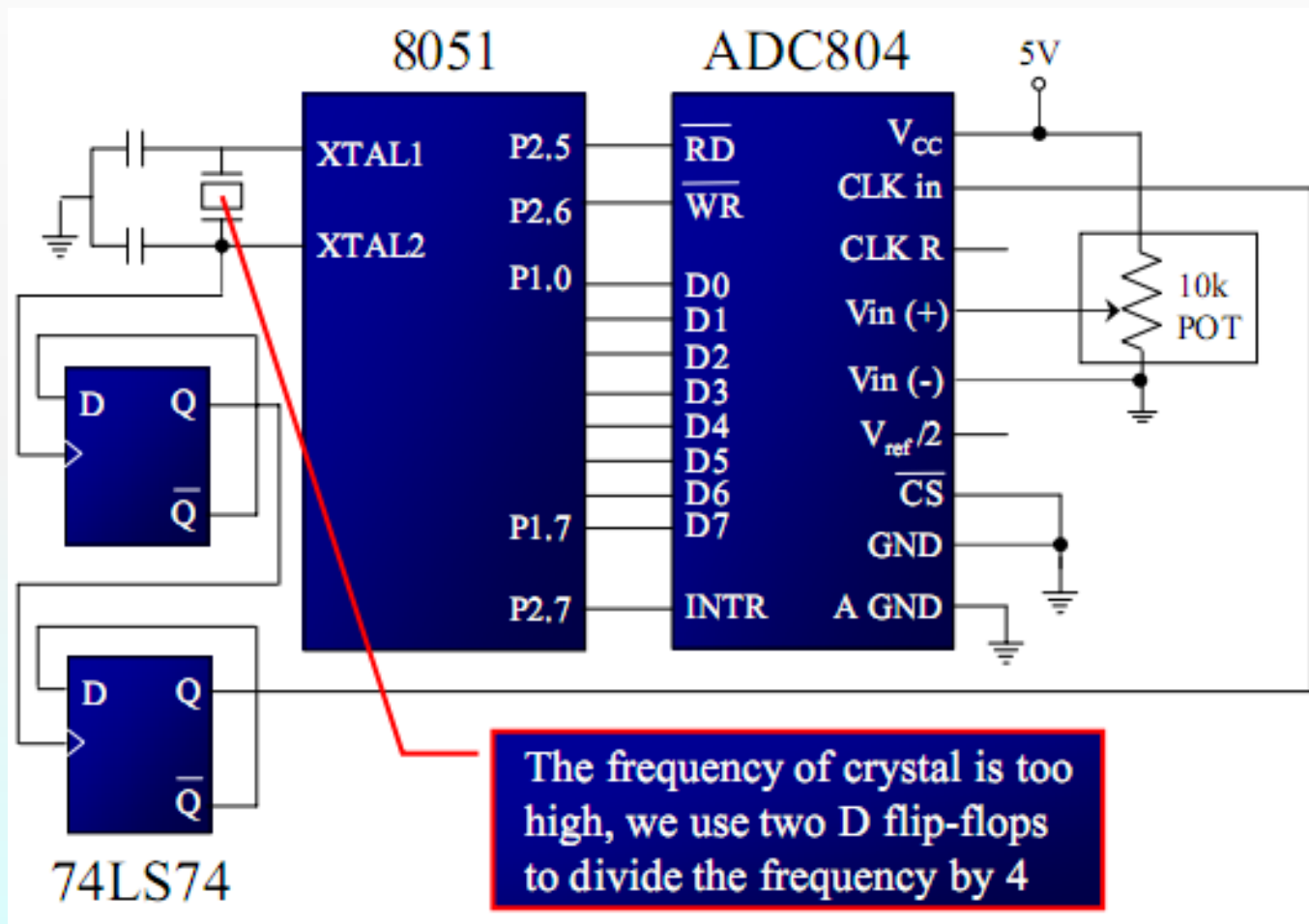


- ◆ Analog ground and digital ground
 - Analog ground is connected to the ground of the analog V_{in}
 - Digital ground is connected to the ground of the V_{cc} pin
- ◆ To isolate the analog V_{in} signal from transient voltages caused by digital switching of the output D0 – D7
 - This contributes to the accuracy of the digital data output

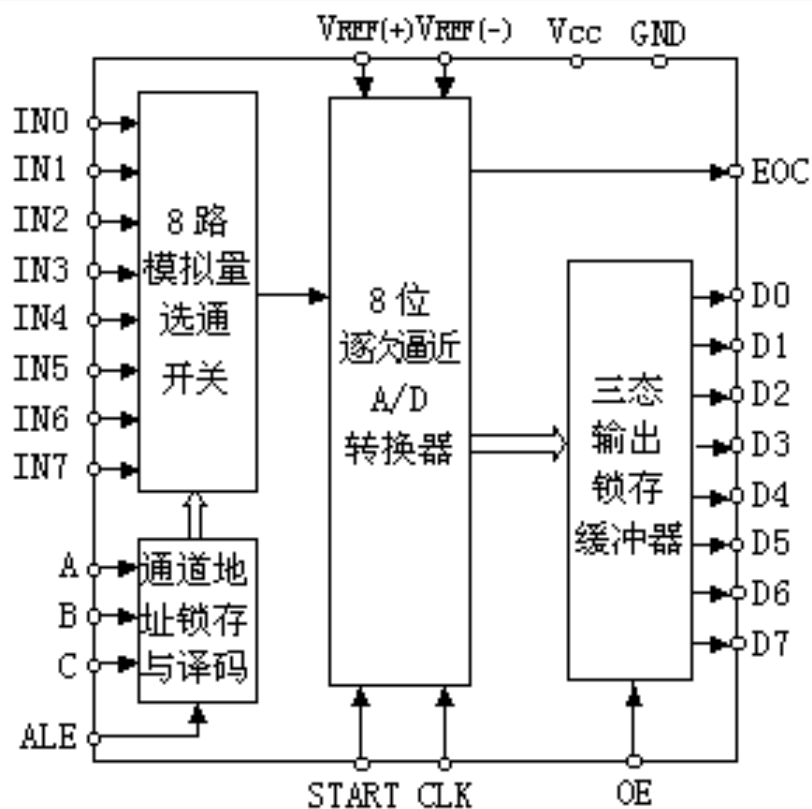


ADC804 Clock from 8051 XTAL2

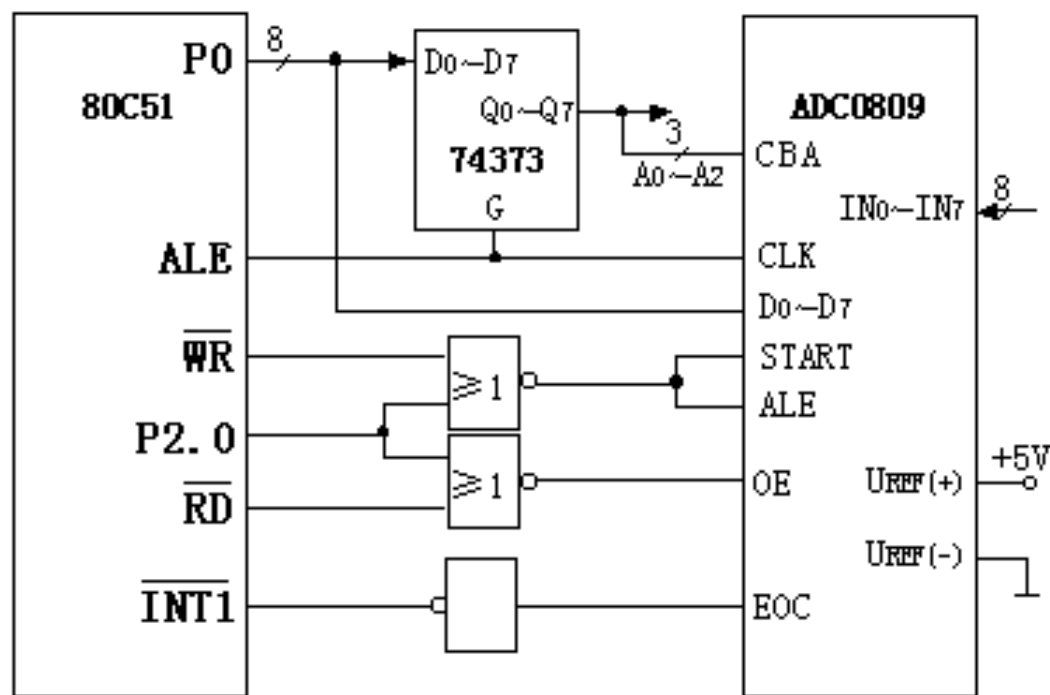
8051 Connection to ADC804 with Clock from XTAL2 of 8051



常用A/D转换器芯片ADC0809



ADC 0809 的结构框图



ADC 0809 与 80C51 的连接电路

§ 13.2.3 A/D转换与接口技术

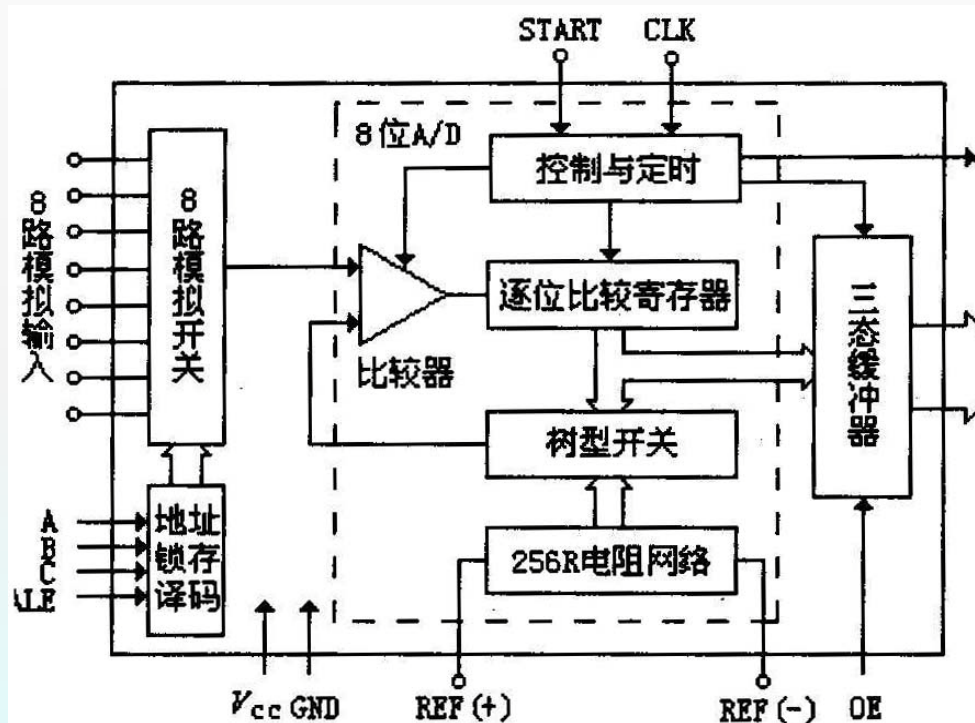
(1) ADC0809的特点

ADC0809是NS (National Semiconductor, 美国国家半导体) 公司生产的逐次逼近型A/D转换器。其特点如下:

- ① 分辨率为8位, 误差1LSB ;
- ② CMOS低功耗器件;
- ③ 转换时间为 $100\text{ }\mu\text{s}$ (当外部时钟输入频率 $f_c = 640\text{ kHz}$) ;
- ④ 很容易与微处理器连接;
- ⑤ 单一电源+5V, 采用单一电源+5V供电时量程为 $0\sim 5\text{V}$;
- ⑥ 无需零位或满量程调整, 使用5V或采用经调整模拟间距的电压基准工作;
- ⑦ 带有锁存控制逻辑的8通道多路输入转换开关;
- ⑧ DIP28封装;
- ⑨ 带锁存器的三态数据输出。
- ⑩ 转换结果读取方式有延时读数、查询EOC=1、EOC申请中断。

§ 13.2.3 A/D转换与接口技术

◆ ADC0809的结构：



ADC0809 结构原理框图

(4)逐次逼近寄存器SAR (8位)：

在A/D转换过程中用以产生设定的数字量和获得正确的与输入模拟量相当的数字量。

(5)D/A部分：

包括电阻网络和树状开关，将SAR中设定的数字量按基准电压VRFE转换成模拟量。

(6)三态输出缓冲器：

A/D转换的结果被送到这里锁存、缓冲，等待结果输出。

(7)控制时序逻辑：

由START信号启动整个A/D转换过程，按CLK时钟节拍控制整个A/D转换过程，转换结束时可提供A/D转换结束信号EOC。

§ 13.2.3 A/D转换与接口技术

(2) ADC0809引脚功能

(6) **ALE**: 地址锁存允许信号输入端。ALE信号有效时将当前转换的通道地址锁存。

(7) **START**: 启动A/D转换信号输入端。

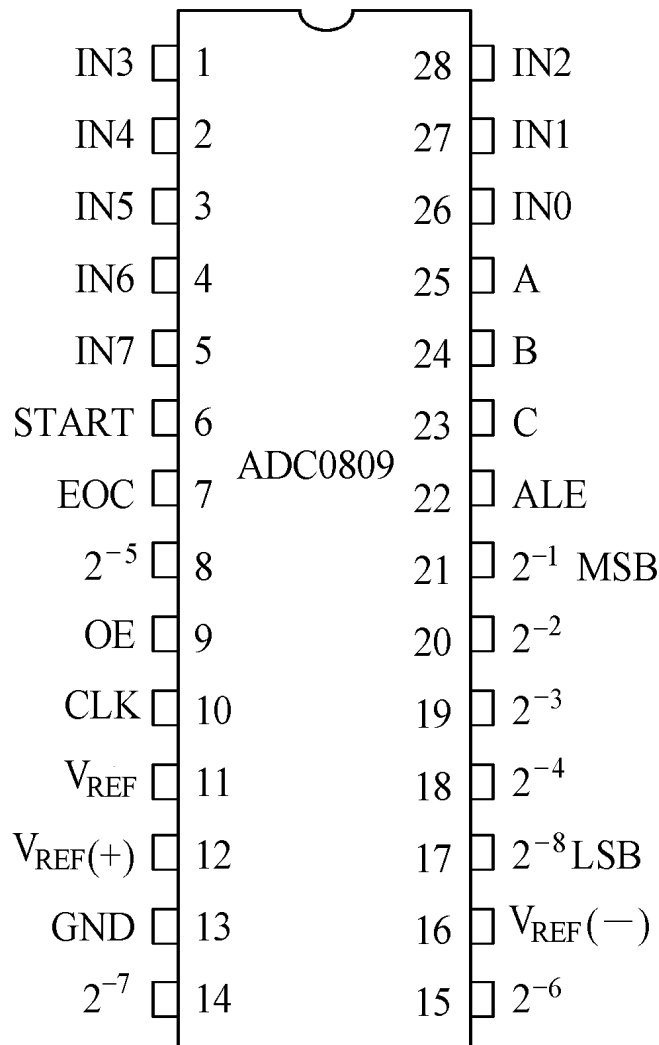
当START端输入一个正脉冲时，立即启动0809进行A/D转换。START端与ALE端连在一起，由80C51WR与0809片选端（例如P2.0）通过或非门相连。

(8) **EOC**: A/D转换结束信号输出端，高电平有效。

(9) **UREF (+)**、**UREF (-)**: 正负基准电压输入端。

(10) **Vcc**: 正电源电压 (+5V)。

GND: 接地端。



§ 13.2.3 A/D转换与接口技术

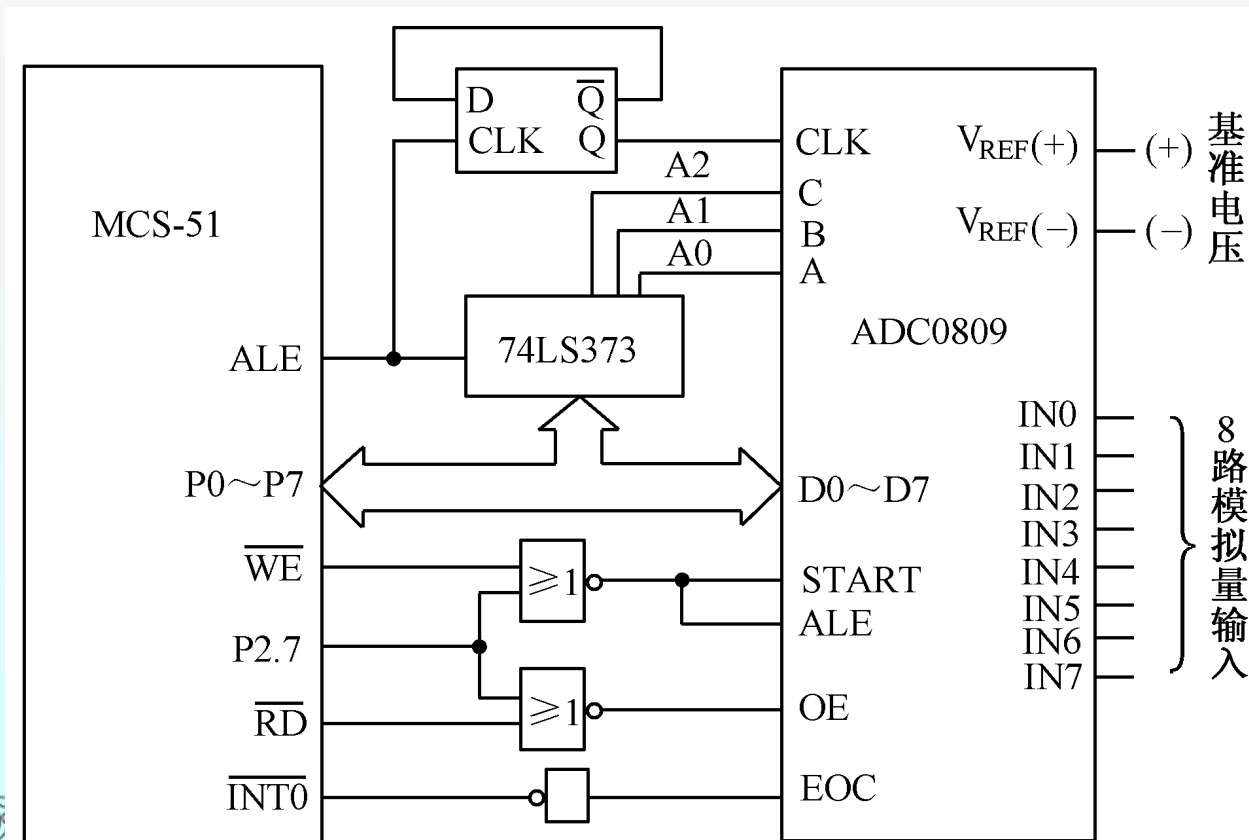
ADC0809与单片机80C51接口

由于ADC0809输出含三态锁存，所以其数据输出可以直接连接MCS-51的数据总线P0口。数据传送方式：

1) 中断方式

2) 查询方式

3) 延时等待方式

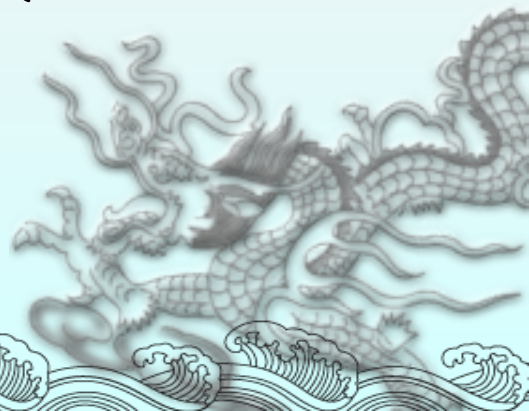


§ 13.2.3 A/D转换与接口技术

(1) 中断方式


用中断方式对8路模拟信号依次A/D转换一次，并把结果存入以30H为首址的内RAM中，试编制程序。

```
ORG 0000H
LJMP STAT
ORG 0013H                                ;中断服务子程序入口地址
LJMP PINT1
ORG 0100H                                ;初始化程序首地址
STAT: MOV R1,#30H                        ;置数据区首址
      MOV R7,#8                          ;置转换通道数
      SETB IT1                           ;置边沿触发方式
      SETB EX1                           ;开外中断
      SETB EA                            ;CPU开中断
      MOV DPTR,#07FF8H                   ;置0809通道0地址
      MOVX @DPTR,A                      ;启动0通道A/D
      SJMP $                            ;等待A/D中断
```



§ 13.2.3 A/D转换与接口技术

	ORG 0200H	
PINT1:	PUSH ACC	;保护现场
	PUSH PSW	
	MOVX A,@DPTR	;读A/D值
	MOV @R1,A	
	INC DPTR	;修正通道地址
	INC R1	;修正数据区地址
	MOVX @DPTR,A	;启动下一通道A/D
	DJNZ R7,GORETI	;判8路采集完否?
	CLR EX1	;8路采集已完,关中断
GORETI:	POP PSW	;恢复现场
	POP ACC	
	RETI	;中断返回



§ 13.2.3 A/D转换与接口技术

(2) 查询方式

工作在查询方式时, 0809 EOC端可直接与80C51 P1口或P3口中任一端线相连。设用P1.0直接与0809 EOC端相连, 试用查询方式编制程序, 对8路模拟信号依次A/D转换一次, 并把结果存入以40H为首址的内RAM中。

```
MAIN:  MOV    R1,#40H           ;置数据区首址
        MOV    R7,#8           ;置通道数
        SETB   P1.0           ;置P1.0输入态
        MOV    DPTR,#07FF8H    ;置0809通道0地址
LOOP:  MOVX    @DPTR,A          ;启动A/D
        JNB    P1.0,$          ;查询A/D转换结束否? 未完继续查询等待
        MOVX   A,@DPTR         ;A/D已结束,读A/D值
        MOV    @R1,A           ;存A/D值
        INC    DPTR            ;修改通道地址
        INC    R1              ;修改数据区地址
        DJNZ   R7,LOOP         ;判8路采集完否?未完继续
        RET                   ;8路采集完毕,返回
```

§ 13.2.3 A/D转换与接口技术

(3) 延时等待方式

工作在延时等待方式时, 0809 EOC端可不必与80C51相连, 是根据时钟频率计算出A/D转换时间, 略微延长后直接读A/D转换值。0809 EOC端开路, $f_{osc}=6\text{MHz}$, 试用延时等待方式编制程序, 对8路模拟信号依次A/D转换一次, 并把结果存入以50H为首址的内RAM中。

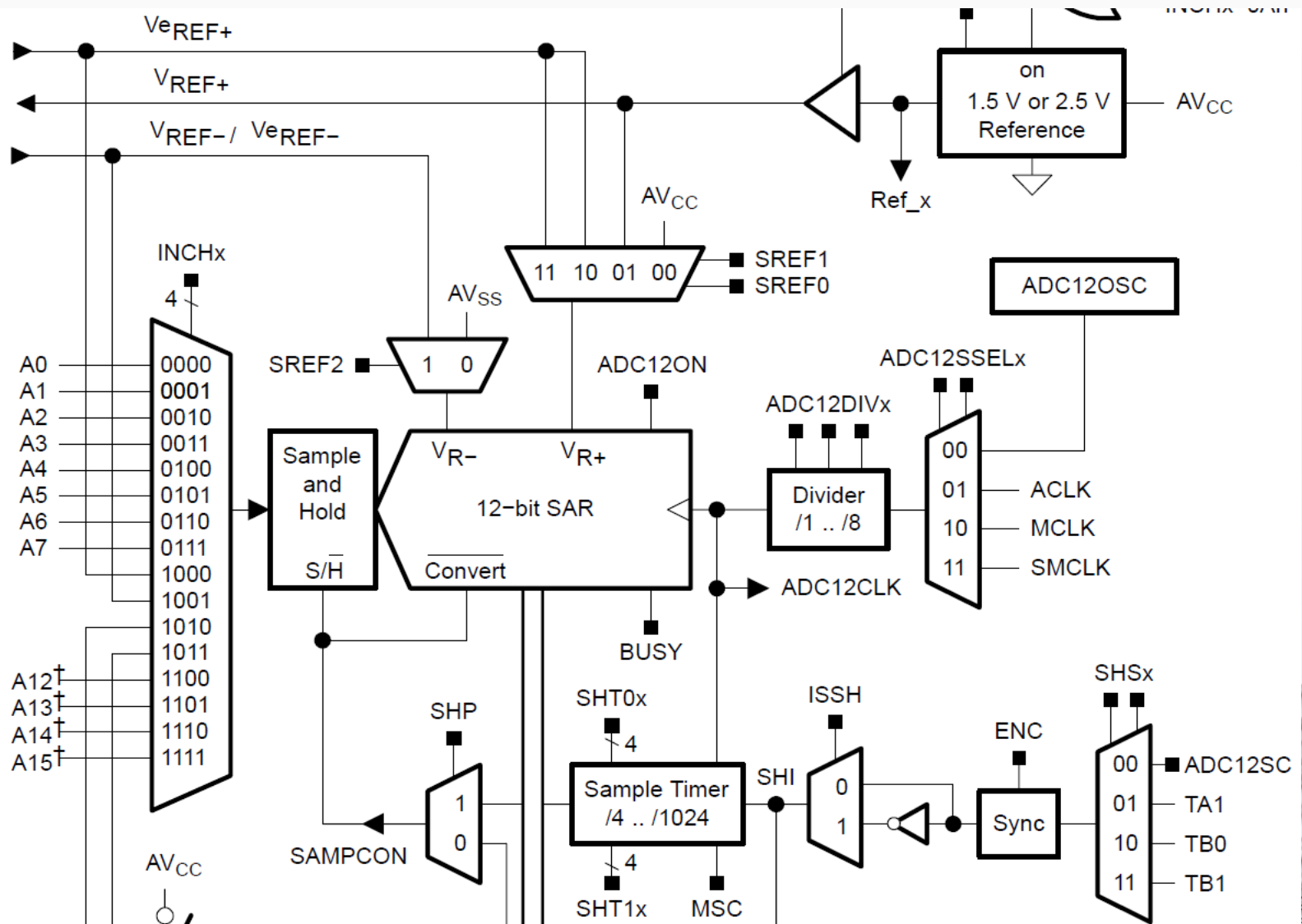
```
MAIN: MOV    R1,#50H           ;置数据区首址
      MOV    R7,#8             ;置通道数
      MOV    DPTR,#07FF8H;置0809通道0地址
LOOP: MOVX   @DPTR,A           ;启动A/D
      MOV    R6,#50
      DJNZ   R6,$              ;延时100μS:2μS×50=100μS
      MOVX   A,@DPTR           ;读A/D值
      MOV    @R1,A
      INC    DPTR              ;修正通道地址
      INC    R1                ;修正数据区地址
      DJNZ   R7,LOOP           ;判8路采集完否?未完继续
      RET                     ;8路采集完毕,返回
```

Modern MCU ADC

Key features of the MSP430x4xx family include:

- ❑ Ultralow-power architecture extends battery life
 - 0.1- μ A RAM retention
 - 0.8- μ A real-time clock mode
 - 250- μ A / MIPS active
- ❑ High-performance analog ideal for precision measurement
 - 12-bit or 10-bit ADC — 200 ksps, temperature sensor, V_{Ref}
 - 12-bit dual-DAC
 - Comparator-gated timers for measuring resistive elements
 - Supply voltage supervisor
- ❑ 16-bit RISC CPU enables new applications at a fraction of the code size.

MSP430F4xx ADC structure



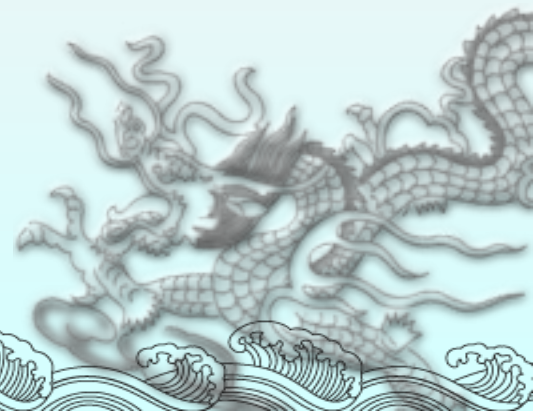
ADC program

- ◆ //*****
- ◆ // 功能：ADC12采样
- ◆ // 入口：uchar i: ADC通道（1---12）
- ◆ // 出口：uint ADC12MEM: AD采样值（12bit）
- ◆ // 说明：1、使用外部参考电源 $V_{r+}=V_{eRef+}$, $V_{r-}=AV_{ss}$;
- ◆ // 2、单通道单次转换模式;
- ◆ // 3、单次转换地址为ADC12MEM0
- ◆ // 4、采用ACLK时钟
- ◆ //*****



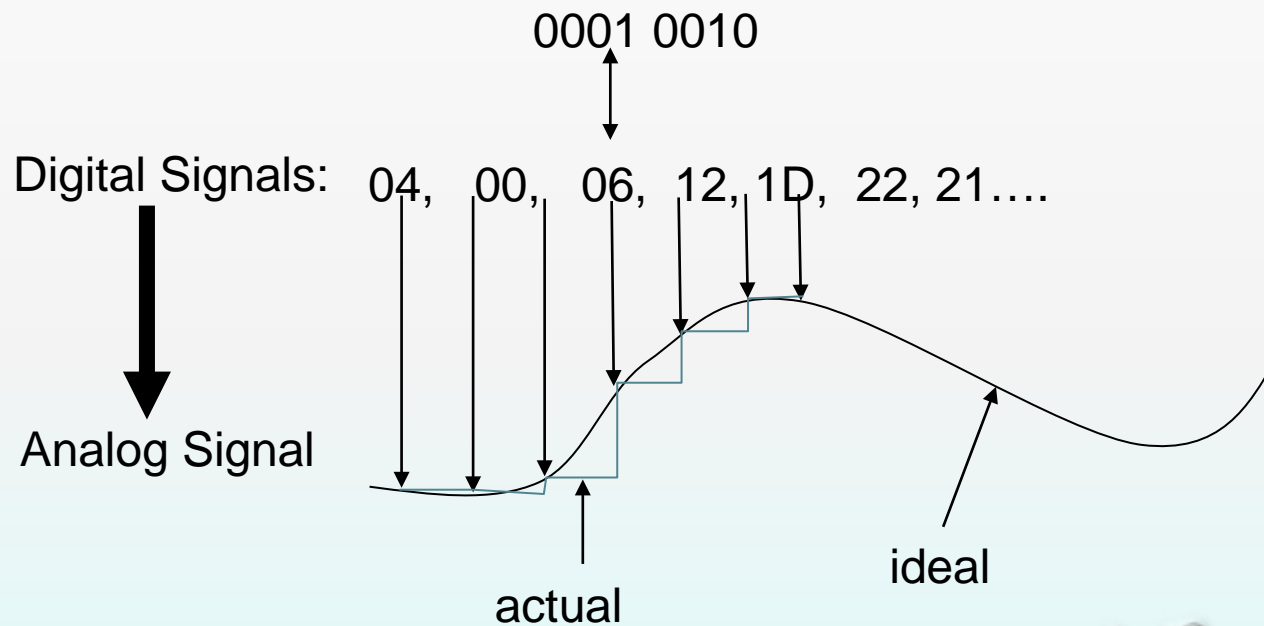
ADC program (2)

```
uint ADC_sample( uchar i )
{
    uint ADC_result;
    ADC12CTL0 &= ~ENC;
    ADC12CTL0 = ADC12ON + SHT0_2;           //打开ADC12内核,设置采样周期4*16*t(aclk)
    //定义ADC12MEM0为单次转换地址;采样信号来自采样定时器;单通道单次转换模式;内核
    //时钟源为MCLK
    ADC12CTL1 = CSTARTADD_0 + SHP + CONSEQ_0 + ADC12SSEL_2;
    ADC12MCTL0 = (i) + SREF_2 + EOS;         //选择第i通道, 参考电源Vr+=Veref+,Vr-=AVss;
    ADC12CTL0 |= ENC + ADC12SC;              //开始转换
    while ( ( ADC12CTL1 & ADC12BUSY ) == 1 ); //ADC12BUSY?
    ADC12CTL0 &= ~ENC;
    ADC12CTL0 &= ~ADC12ON;                   //关闭ADC内核电源
    ADC_result = ADCMEM[0];                  //将ADC12MEMx给Result
    _NOP();
    return ADC_result;
}
```



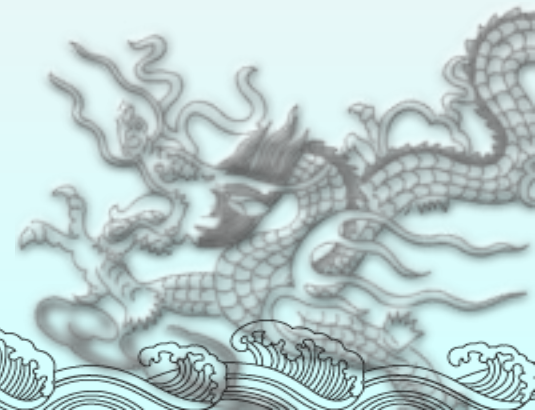
§ 13-3 Interfacing to DAC

Digital-to-analog convert



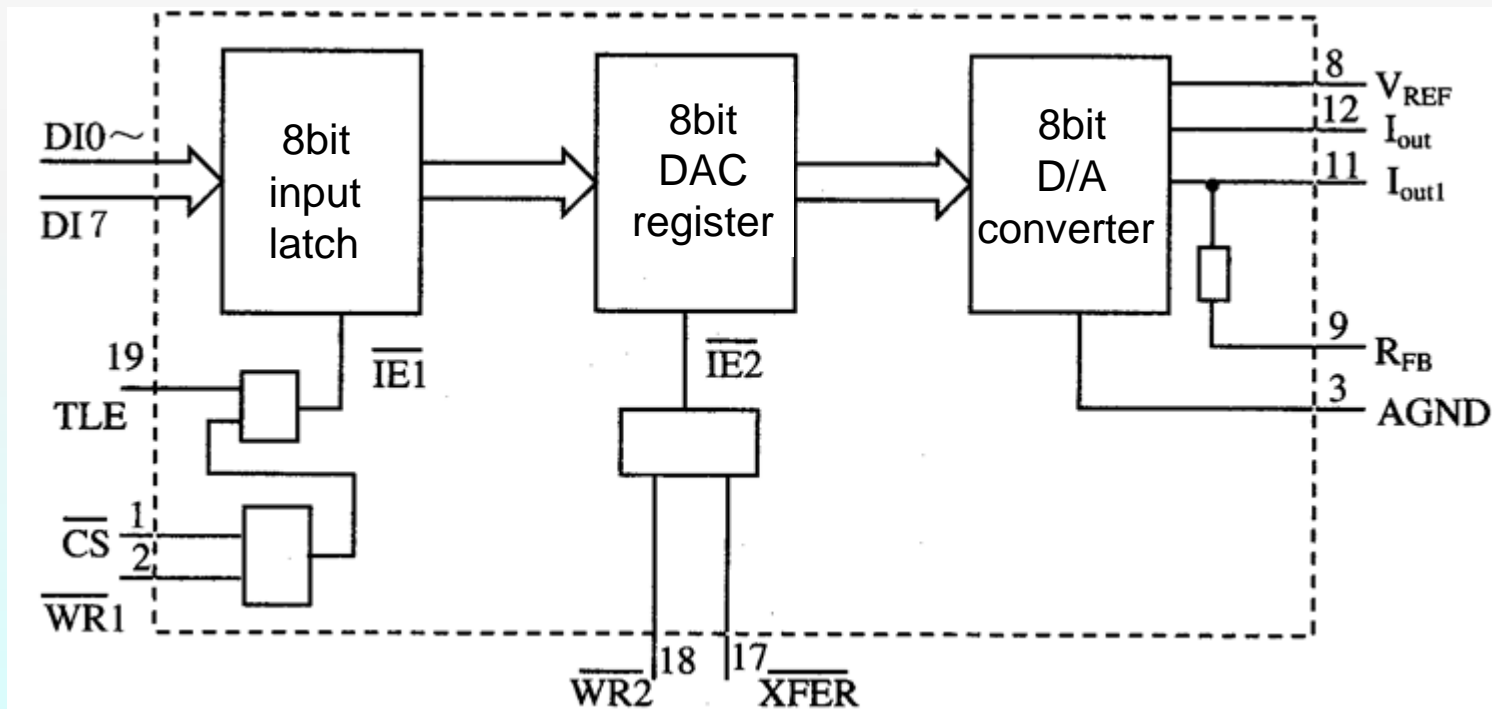
DAC Devices

- There are several series of DAC, which have different functions.
- Features
 - a. Format of digital numbers: binary number
8 bits, 10 bits, 12 bits, 14 bits, 16 bits
 - b. Output form : Current output and Voltage output
 - c. Self-contained reference voltage V_{REF} and circumscribed reference voltage V_{REF} ◦
 - d. Output without latch 、 Output with latch 、
Buffer with two-stage
 - e. Input form: parallel and serial

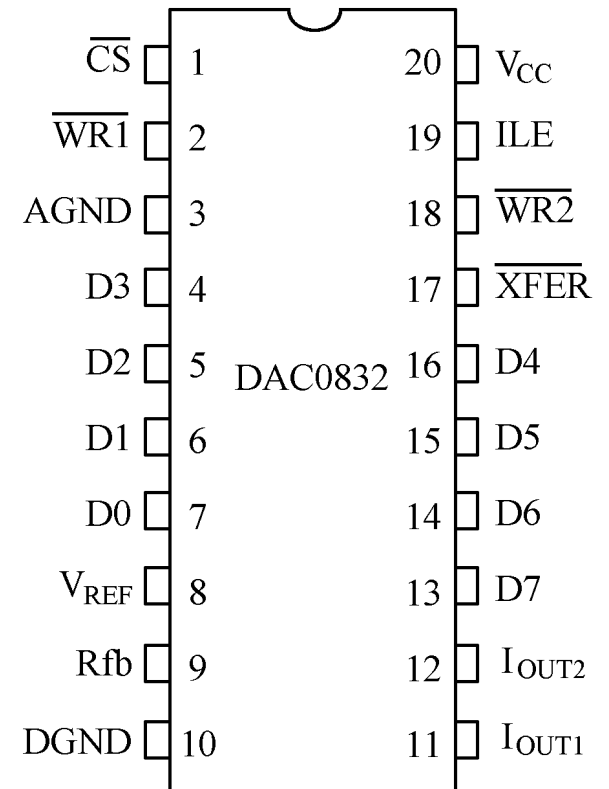


❖ DAC with latch

- DAC 0832 is a typical 8 bit D/A chip with two-data-buffer.
- Produced by National Semiconductor



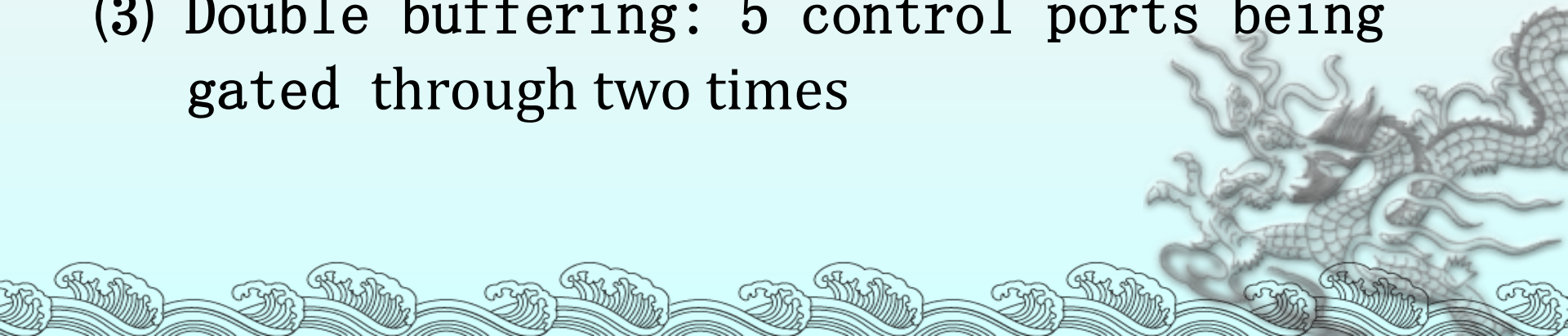
◆ DAC0832 pin



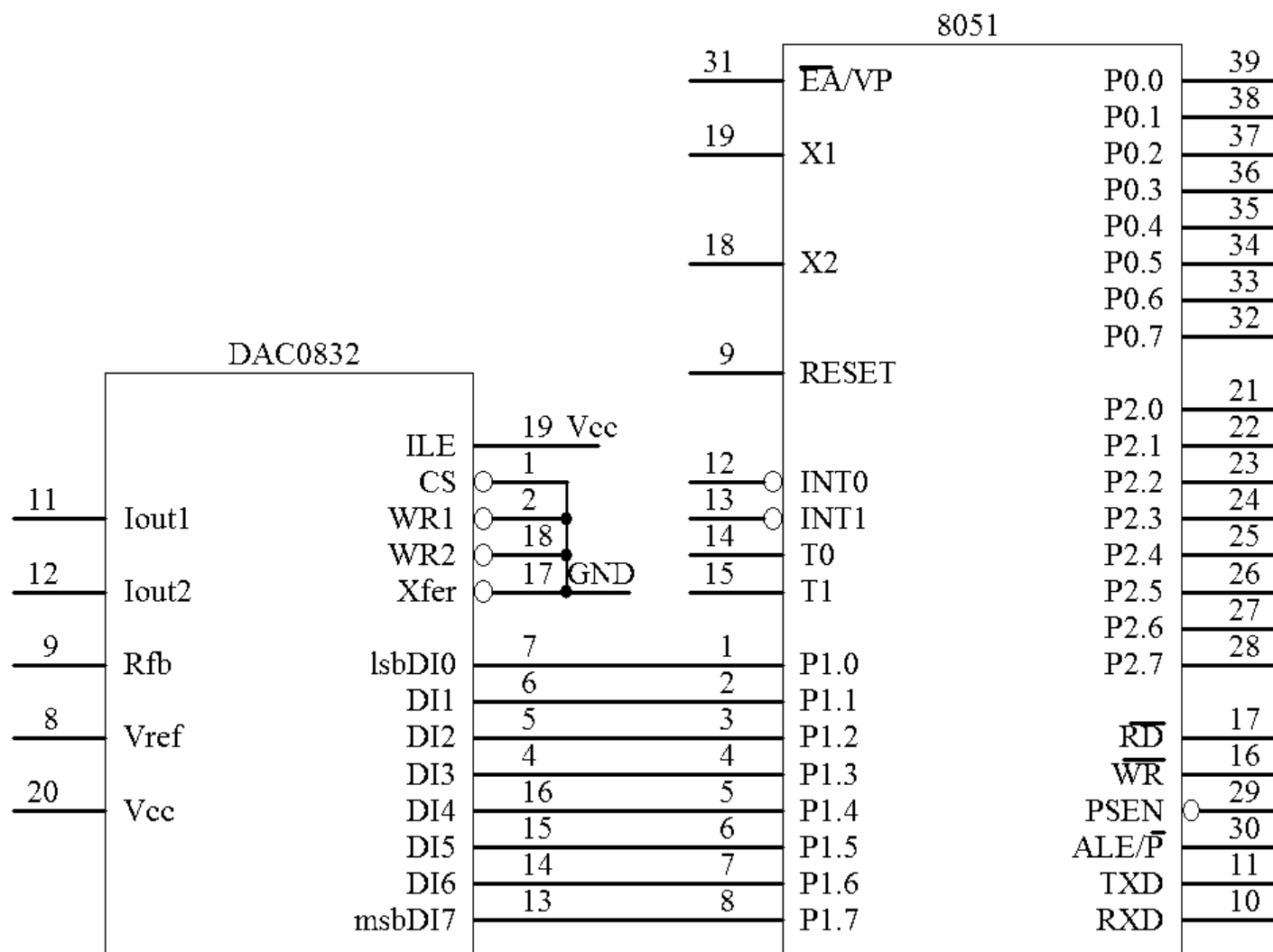
◆ DAC 0832 operating mode

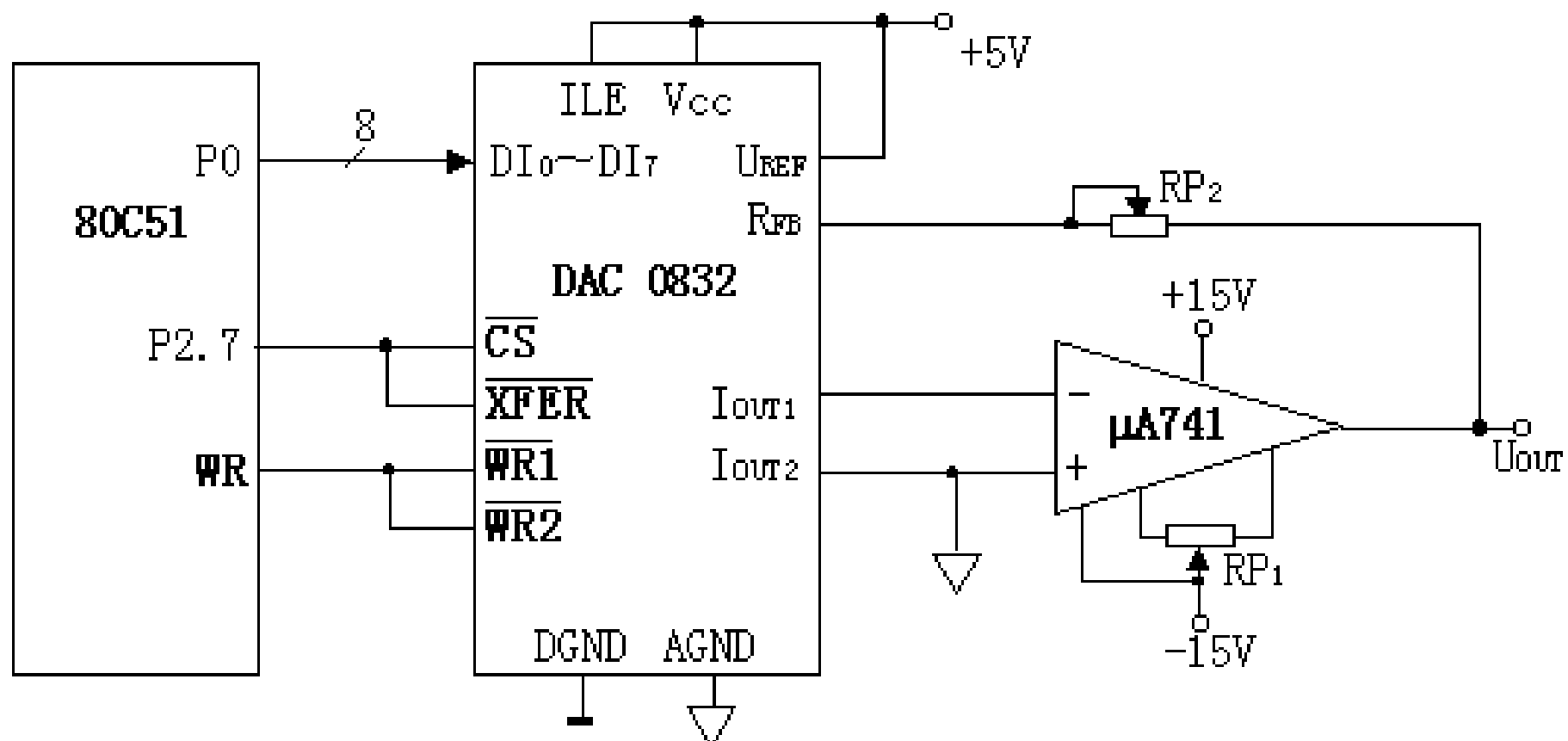
Using command to control: ILE、CS、WR1、WR2、XFER

- (1) Direct connection: 5 control ports are all effective, direct D/A
- (2) Single buffering: 5 control ports being gated once
- (3) Double buffering: 5 control ports being gated through two times



(1) Direct connection:



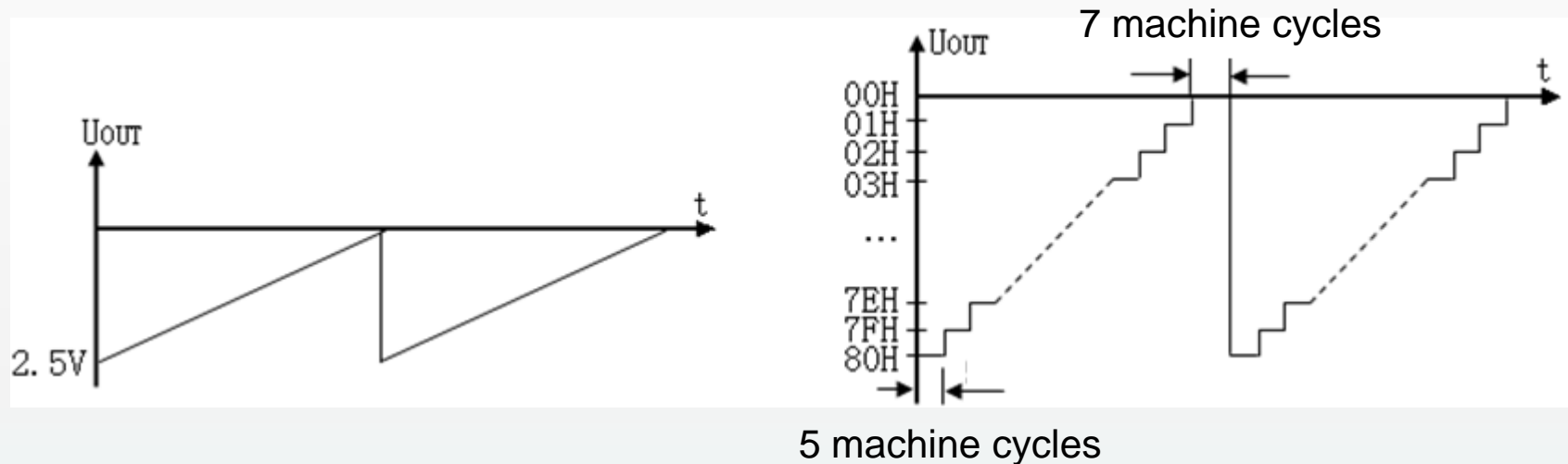


DAC 0832 Single buffering mode

Figure 13-1

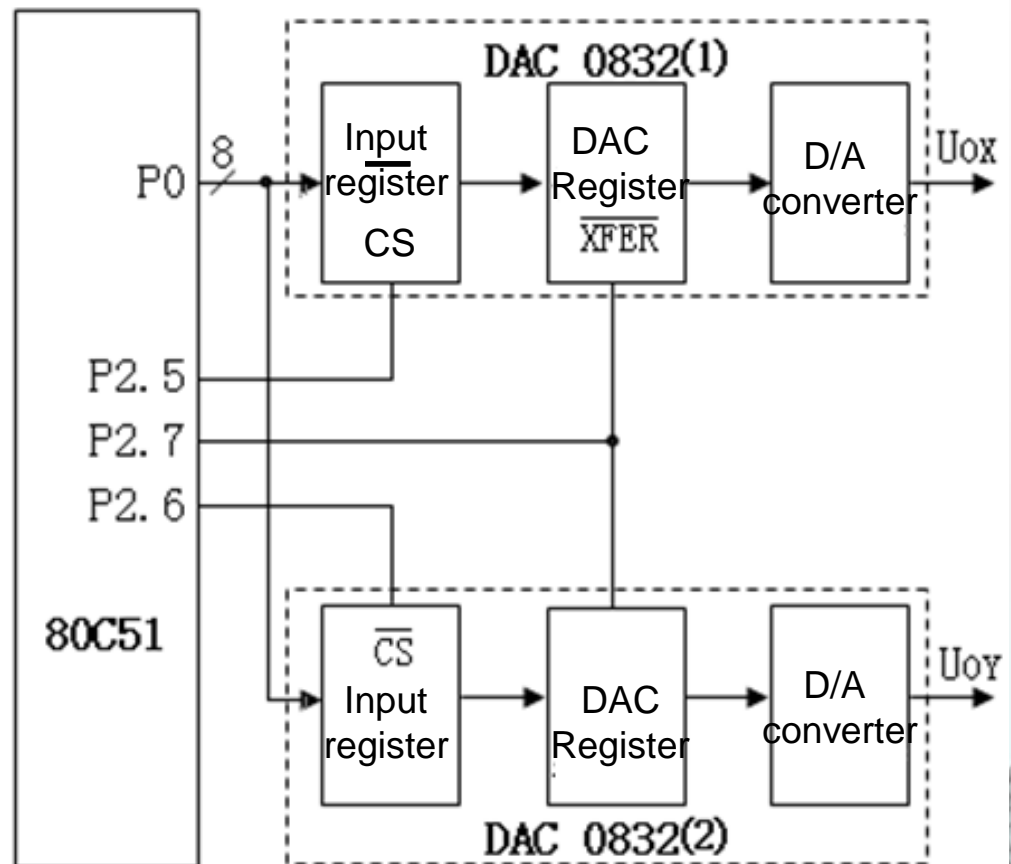
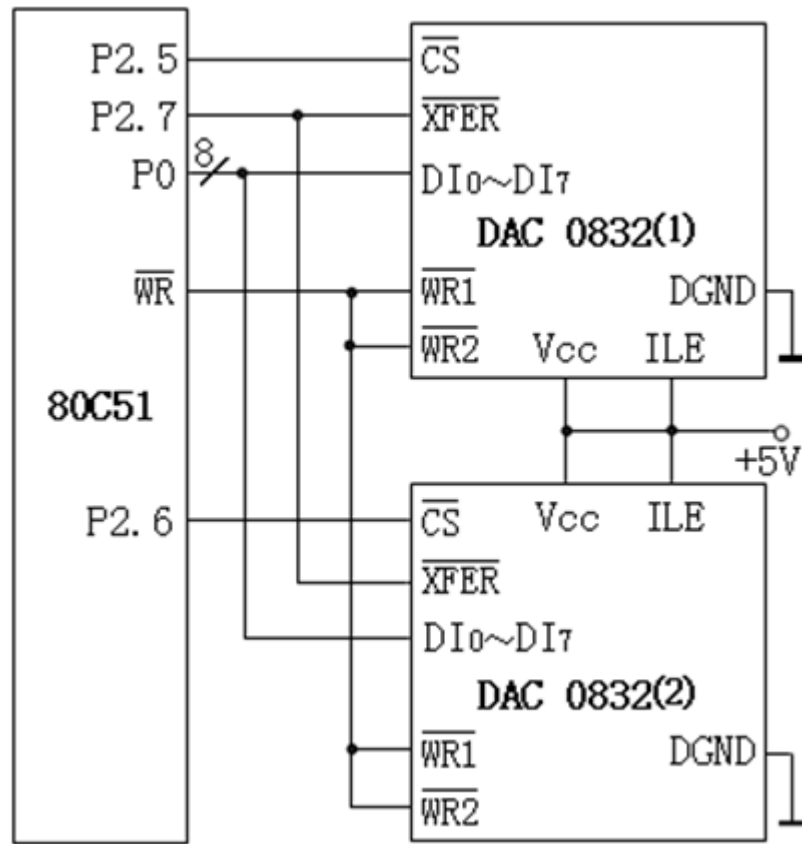
For Figure 13-1

Output saw tooth wave as following, amplitude $U_{REF}/2=2.5V$



```
START: MOV    DPTR, #7FFFH ;set DAC0832 address
LOOP1: MOV    R7, #80H      ;set saw tooth wave amplitude 1 machine cycle
LOOP2: MOV    A, R7         ;read output value
        MOVX  @DPTR, A      ;output;
        DJNZ  R7, LOOP2     ;
        SJMP  LOOP1         ;
```

	1
	2
	2
	2



Double buffering mode

THANK YOU!!

